



**Fast Thyristor
Type TFI573-2000-12**

Low switching losses
Low reverse recovery charge
Distributed amplified gate for high di_T/dt

Mean on-state current	I_{TAV}	2000 A
Repetitive peak off-state voltage	V_{DRM}	1000...1200 V
Repetitive peak reverse voltage	V_{RRM}	
Turn-off time	t_q	10.0, 12.5, 16.0, 20.0 μs
V_{DRM}, V_{RRM}, V	1000	1200
Voltage code	10	12
$T_j, ^\circ C$	-60...+125	

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions
ON-STATE				
I_{TAV}	Mean on-state current	A	2000 2376 3644	$T_c=92^\circ C$; Double side cooled; $T_c=85^\circ C$; Double side cooled; $T_c=55^\circ C$; Double side cooled; 180° half-sine wave; 50 Hz
I_{TRMS}	RMS on-state current	A	3140	$T_c=92^\circ C$; Double side cooled; 180° half-sine wave; 50 Hz
I_{TSM}	Surge on-state current	kA	65.0 75.0	$T_j=T_{jmax}$ $T_j=25^\circ C$ 180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=50$ μs ; $di_G/dt=2$ A/ μs
			68.0 78.0	$T_j=T_{jmax}$ $T_j=25^\circ C$ 180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=50$ μs ; $di_G/dt=2$ A/ μs
I^2t	Safety factor	$A^2s \cdot 10^3$	21100 28100	$T_j=T_{jmax}$ $T_j=25^\circ C$ 180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=50$ μs ; $di_G/dt=2$ A/ μs
			19100 25200	$T_j=T_{jmax}$ $T_j=25^\circ C$ 180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=50$ μs ; $di_G/dt=2$ A/ μs
BLOCKING				
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	1000...1200	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; 50 Hz; Gate open
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	1100...1300	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; single pulse; Gate open
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.6 \cdot V_{DRM}$ $0.6 \cdot V_{RRM}$	$T_j=T_{jmax}$; Gate open

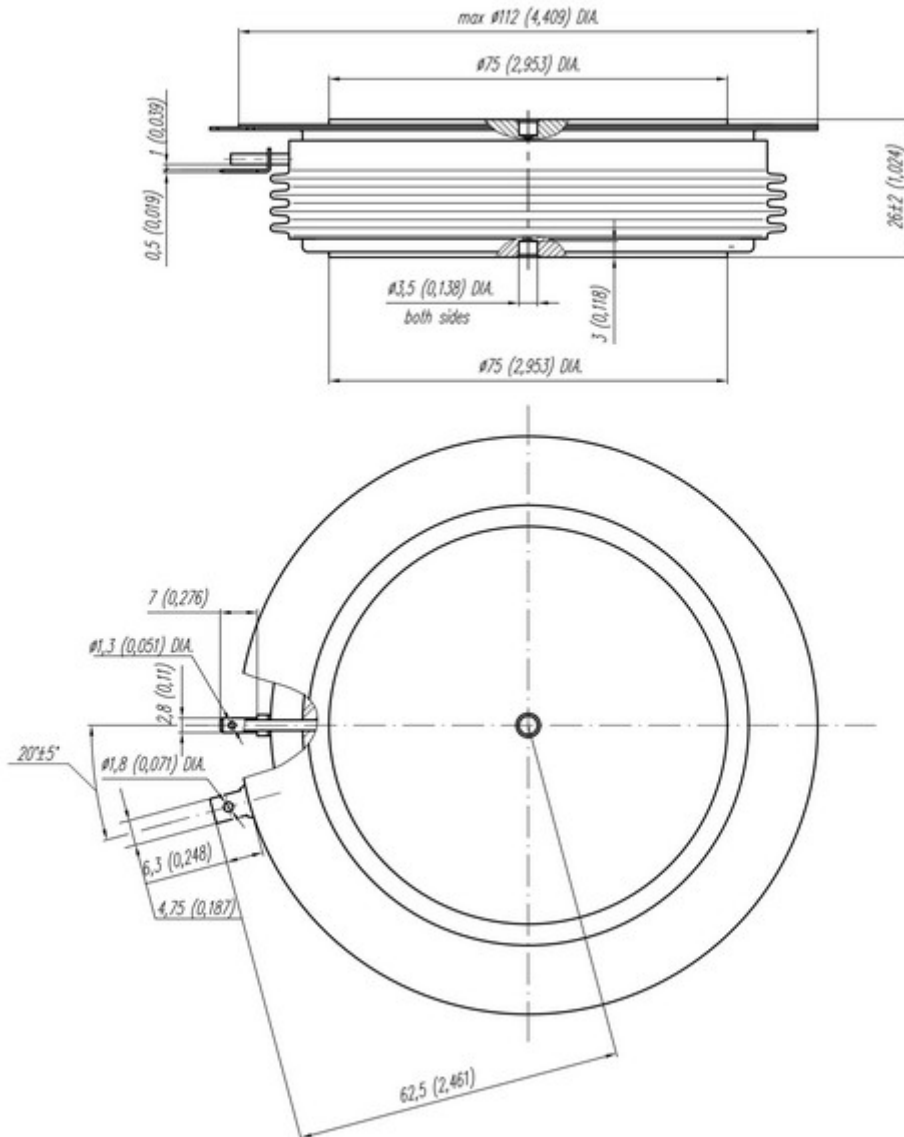
TRIGGERING				
I_{FGM}	Peak forward gate current	A	10	$T_j = T_{j\ max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	8	$T_j = T_{j\ max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/ μ s	2500	$T_j = T_{j\ max}$; $V_D = 0.67 \cdot V_{DRM}$; $I_{TM} = 4000$ A; Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 2$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	$^{\circ}$ C	-60...+50	
T_j	Operating junction temperature	$^{\circ}$ C	-60...+125	
MECHANICAL				
F	Mounting force	kN	40.0...50.0	
a	Acceleration	m/s ²	50	Device clamped

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{TM}	Peak on-state voltage, max	V	2.15	$T_j = 25$ $^{\circ}$ C; $I_{TM} = 6280$ A	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.456	$T_j = T_{j\ max}$;	
r_T	On-state slope resistance, max	m Ω	0.090	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$	
I_H	Holding current, max	mA	1000	$T_j = 25$ $^{\circ}$ C; $V_D = 12$ V; Gate open	
BLOCKING					
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	300	$T_j = T_{j\ max}$; $V_D = V_{DRM}$; $V_R = V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j = T_{j\ max}$; $V_D = 0.67 \cdot V_{DRM}$; Gate open	
TRIGGERING					
V_{GT}	Gate trigger direct voltage, max	V	3.00 3.00 1.50	$T_j = T_{j\ min}$ $T_j = 25$ $^{\circ}$ C $T_j = T_{j\ max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current
I_{GT}	Gate trigger direct current, max	mA	500 300 150	$T_j = T_{j\ min}$ $T_j = 25$ $^{\circ}$ C $T_j = T_{j\ max}$	
V_{GD}	Gate non-trigger direct voltage, min	V	0.35	$T_j = T_{j\ max}$; $V_D = 0.67 \cdot V_{DRM}$;	
I_{GD}	Gate non-trigger direct current, min	mA	65.00	Direct gate current	
SWITCHING					
t_{gd}	Delay time, max	μ s	0.80	$T_j = 25$ $^{\circ}$ C; $V_D = 600$ V; $I_{TM} = I_{TAV}$; $di/dt = 200$ A/ μ s;	
t_{gt}	Turn-on time ²⁾ , max	μ s	1.60, 2.00, 2.50, 3.20	Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 2$ A/ μ s	
t_q	Turn-off time ³⁾ max	μ s	10.0, 12.5, 16.0, 20.0 12.5, 16.0, 20.0, 25.0	$dv_D/dt = 50$ V/ μ s; $dv_D/dt = 200$ V/ μ s;	$T_j = T_{j\ max}$; $I_{TM} = I_{TAV}$; $di_R/dt = -10$ A/ μ s; $V_R = 100$ V; $V_D = 0.67 V_{DRM}$
Q_{rr}	Total recovered charge, max	μ C	220	$T_j = T_{j\ max}$; $I_{TM} = 2000$ A;	
t_{rr}	Reverse recovery time, max	μ s	3.8	$di_R/dt = -50$ A/ μ s;	
I_{rrM}	Peak reverse recovery current, max	A	115	$V_R = 100$ V	

THERMAL					
R_{thjc}	Thermal resistance, junction to case, max	°C/W	0.0085	Direct current	Double side cooled
R_{thjc-A}			0.0187		Anode side cooled
R_{thjc-K}			0.0153		Cathode side cooled
R_{thck}	Thermal resistance, case to heatsink, max	°C/W	0.0020	Direct current	
MECHANICAL					
w	Weight, max	g	1170		
D_s	Surface creepage distance	mm (inch)	36.60 (1.441)		
D_a	Air strike distance	mm (inch)	16.20 (0.638)		

PART NUMBERING GUIDE								NOTES																							
TFI	573	2000	12	A2	P3	K4	N																								
1	2	3	4	5	6	7	8																								
1. TFI — fast inverter thyristor								1) Critical rate of rise of off-state voltage																							
2. Design version								<table border="1"> <thead> <tr> <th>Symbol of Group</th> <th>P2</th> <th>K2</th> <th>E2</th> <th>A2</th> <th>T1</th> <th>P1</th> <th>M1</th> </tr> </thead> <tbody> <tr> <td>$(dv_D/dt)_{crit}$, V/μs</td> <td>200</td> <td>320</td> <td>500</td> <td>1000</td> <td>1600</td> <td>2000</td> <td>2500</td> </tr> </tbody> </table>								Symbol of Group	P2	K2	E2	A2	T1	P1	M1	$(dv_D/dt)_{crit}$, V/ μ s	200	320	500	1000	1600	2000	2500
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3. Mean on-state current, A								2) Turn-on time																							
4. Voltage code								<table border="1"> <thead> <tr> <th>Symbol of group</th> <th>T4</th> <th>P4</th> <th>M4</th> <th>K4</th> </tr> </thead> <tbody> <tr> <td>t_{gt}, μs</td> <td>1.60</td> <td>2.00</td> <td>2.50</td> <td>3.20</td> </tr> </tbody> </table>								Symbol of group	T4	P4	M4	K4	t_{gt} , μ s	1.60	2.00	2.50	3.20						
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7. Group of turn-on time																															
8. Ambient conditions: N – normal; T – tropical																															



All dimensions in millimeters (inches)

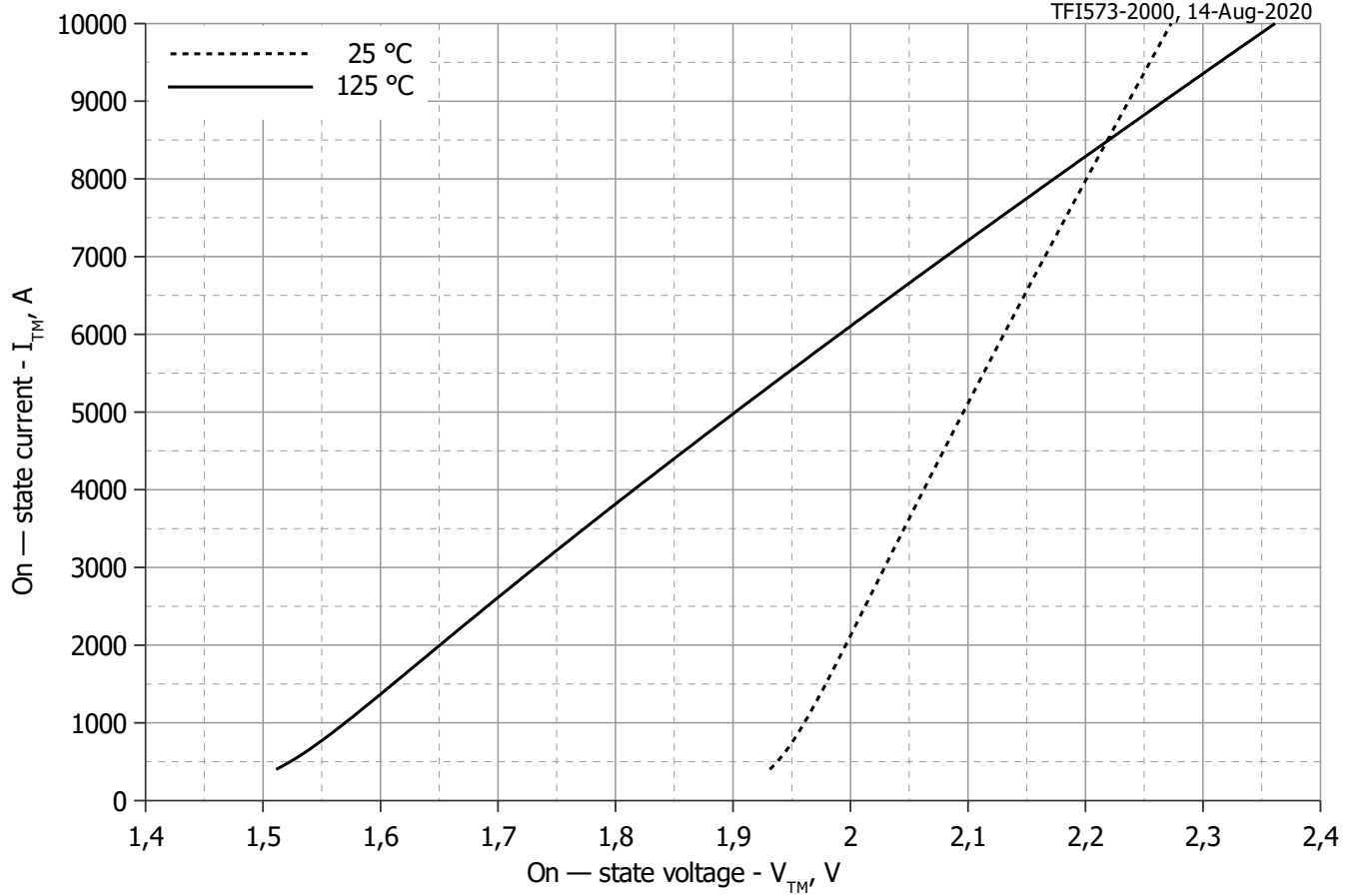


Fig 1 – On-state characteristics of Limit device

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j\text{max}}$
A	1.73646378	1.15209372
B	0.00004772	0.00012450
C	0.03947643	0.07620628
D	-0.00304265	-0.00737623

On-state characteristic model (see Fig. 1).

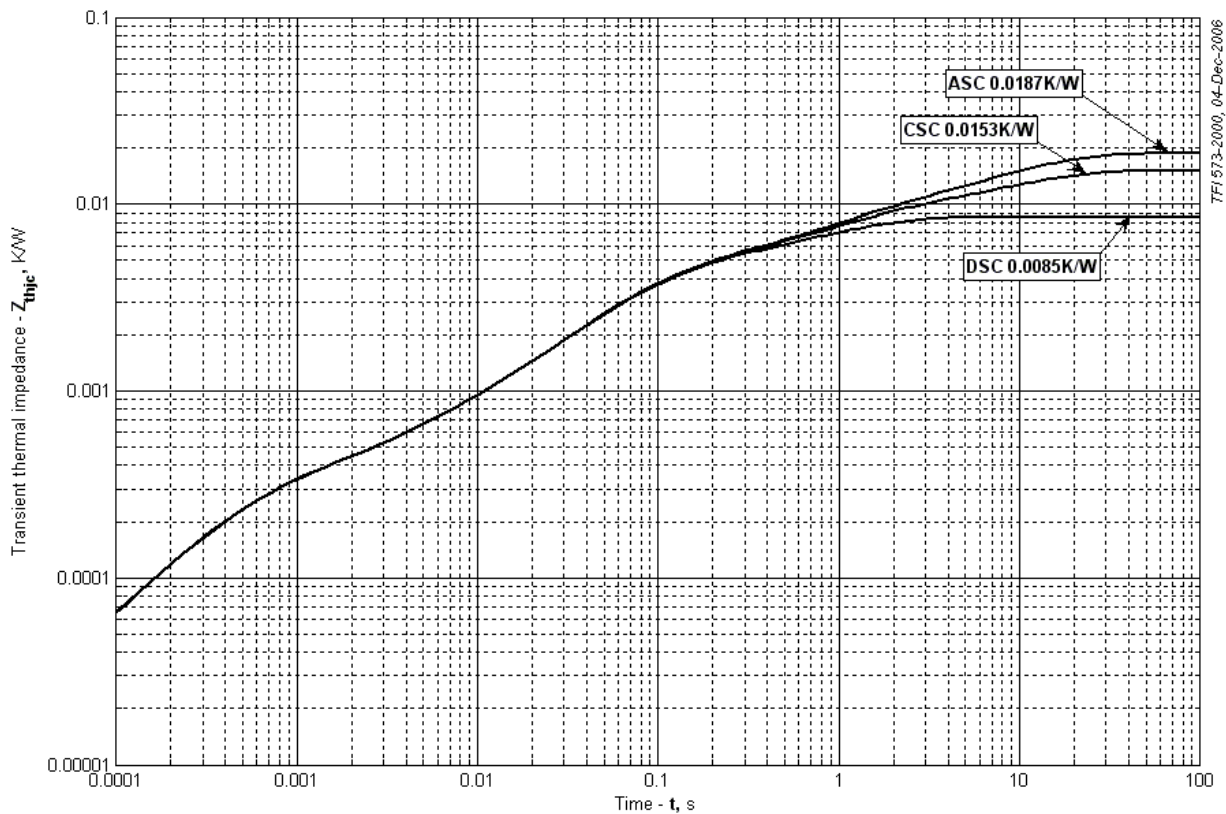


Fig 2 – Transient thermal impedance

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where $i = 1$ to n , n is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t .

R_i = Amplitude of p_{th} term.

τ_i = Time constant of r_{th} term.

DC Double side cooled

i	1	2	3	4	5	6
R_i , K/W	0.0003136	0.003279	0.0001485	0.0007865	0.0002694	0.003703
τ_i , s	1.181	0.06771	0.003331	0.145	0.0004353	0.9499

DC Anode side cooled

i	1	2	3	4	5	6
R_i , K/W	0.01013	0.004062	0.0009701	0.00306	0.000148	0.0002685
τ_i , s	9.747	1.058	0.1302	0.06675	0.003276	0.0004342

DC Cathode side cooled

i	1	2	3	4	5	6
R_i , K/W	0.006619	0.004032	0.0008219	0.003231	0.000147	0.0002716
τ_i , s	9.745	1.026	0.143	0.06778	0.00342	0.0004396

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2).

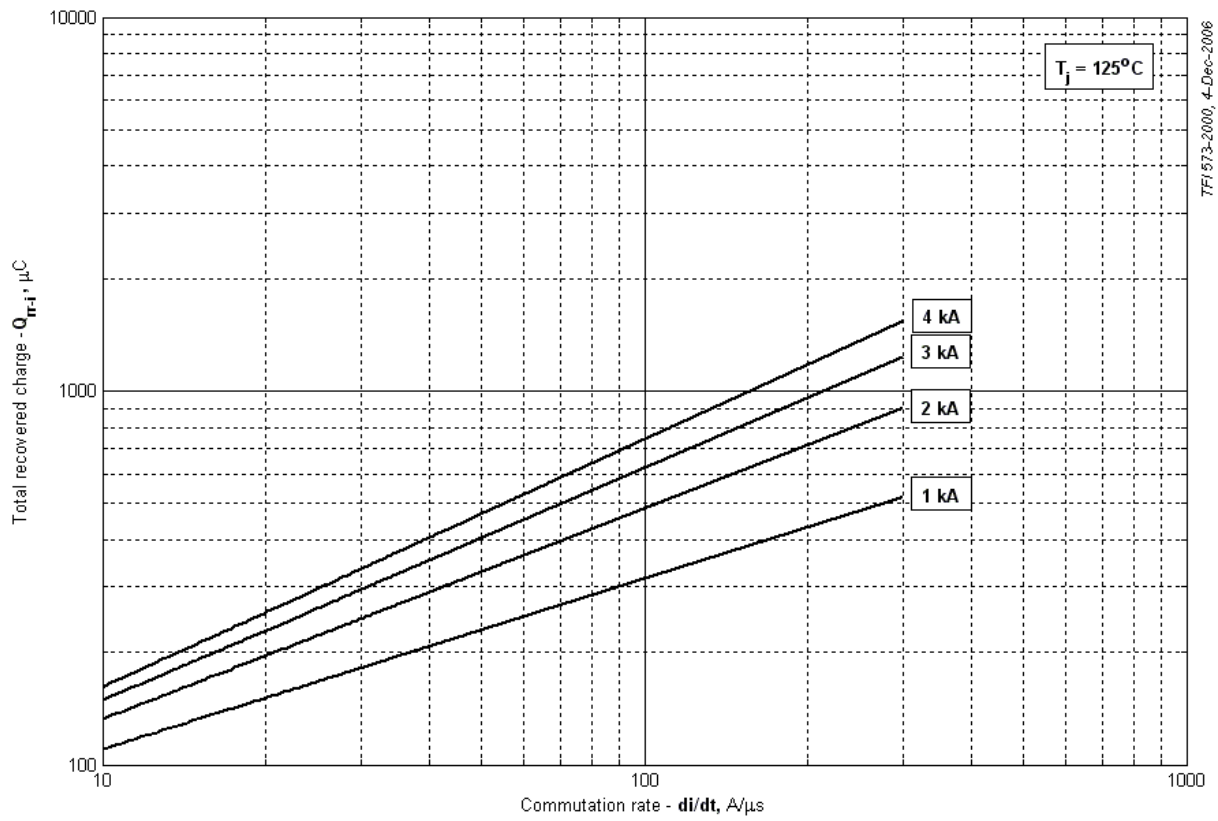


Fig 3 – Total recovered charge, Q_{rr-i} (integral)

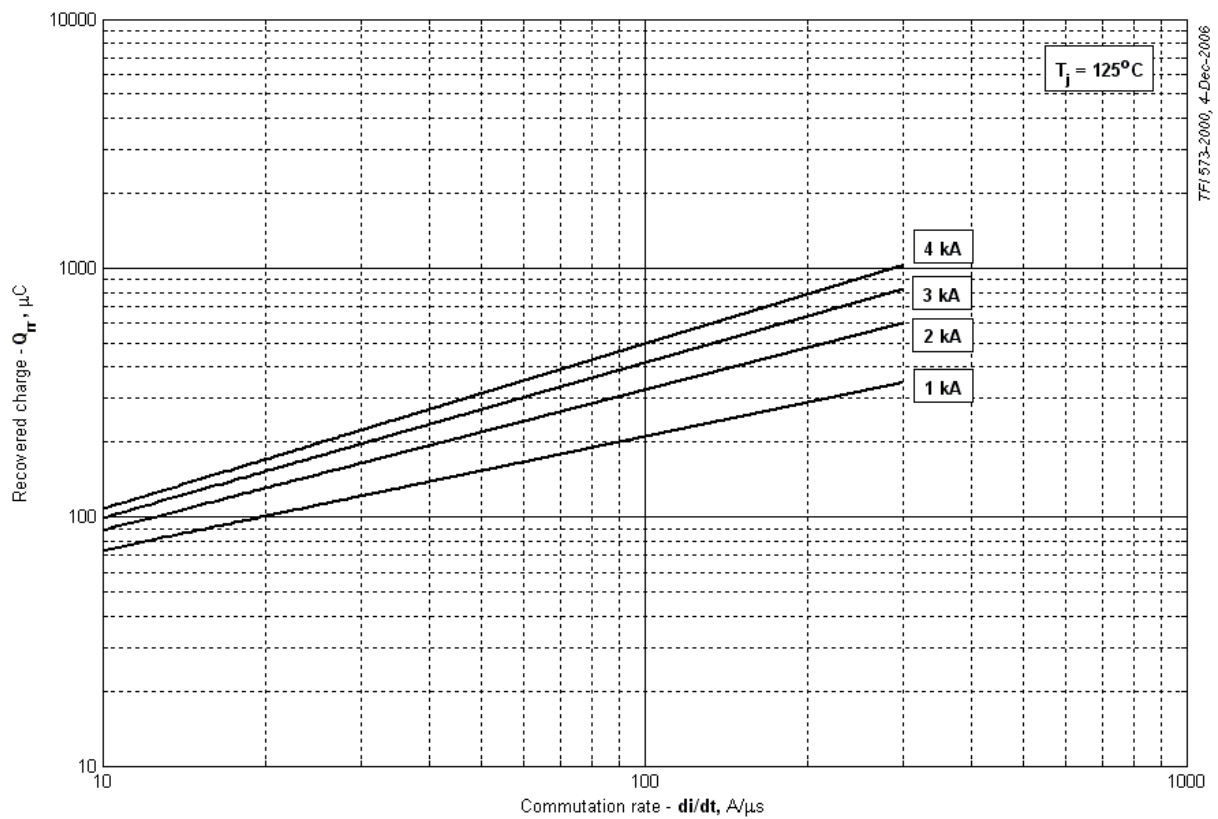


Fig 4 - Recovered charge, Q_{rr} (linear)

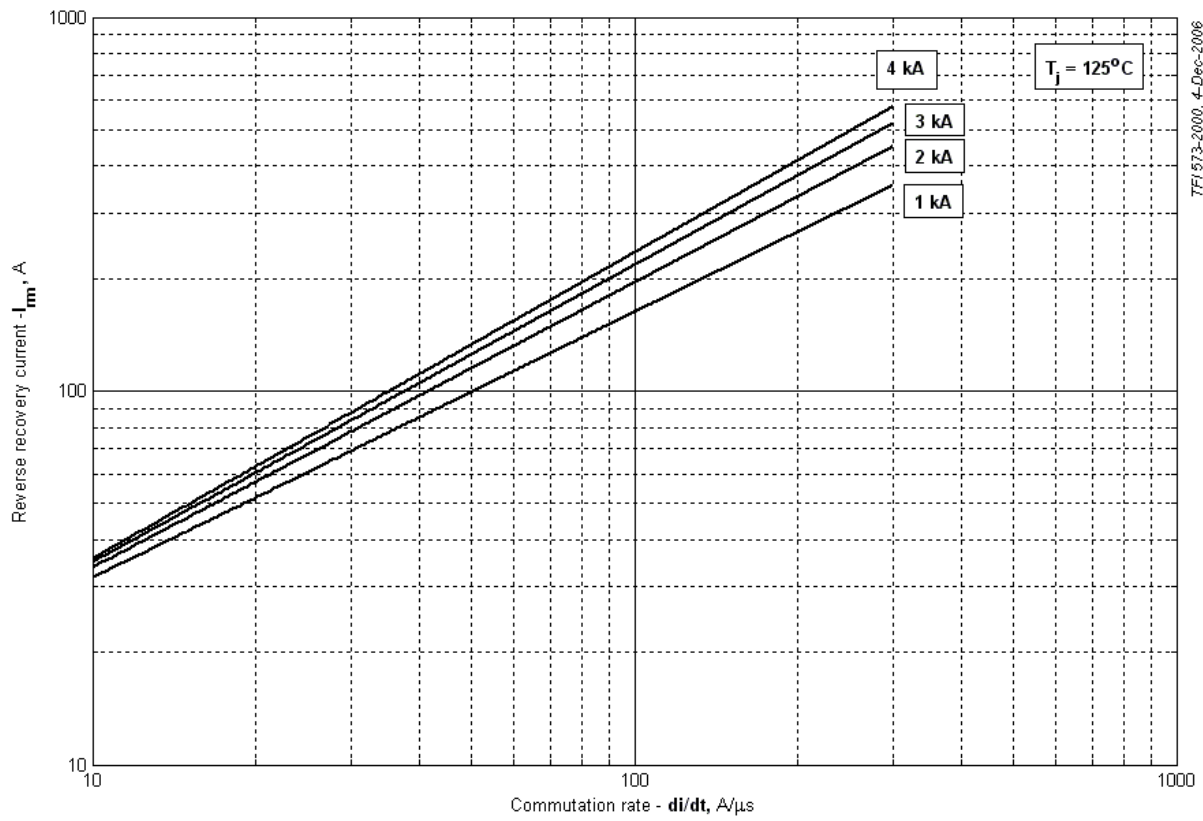


Fig 5 – Peak reverse recovery current, I_{rm}

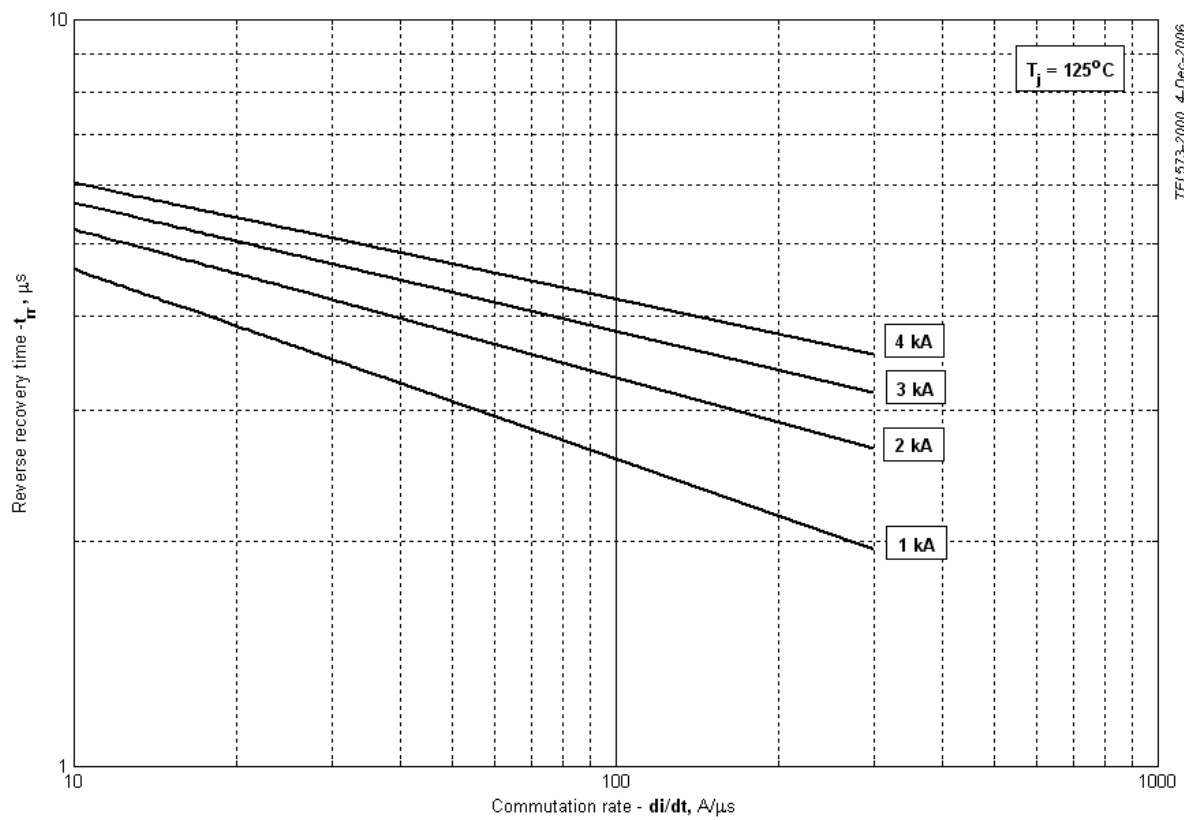


Fig 6 – Typical recovery time, t_{rr} (linear)

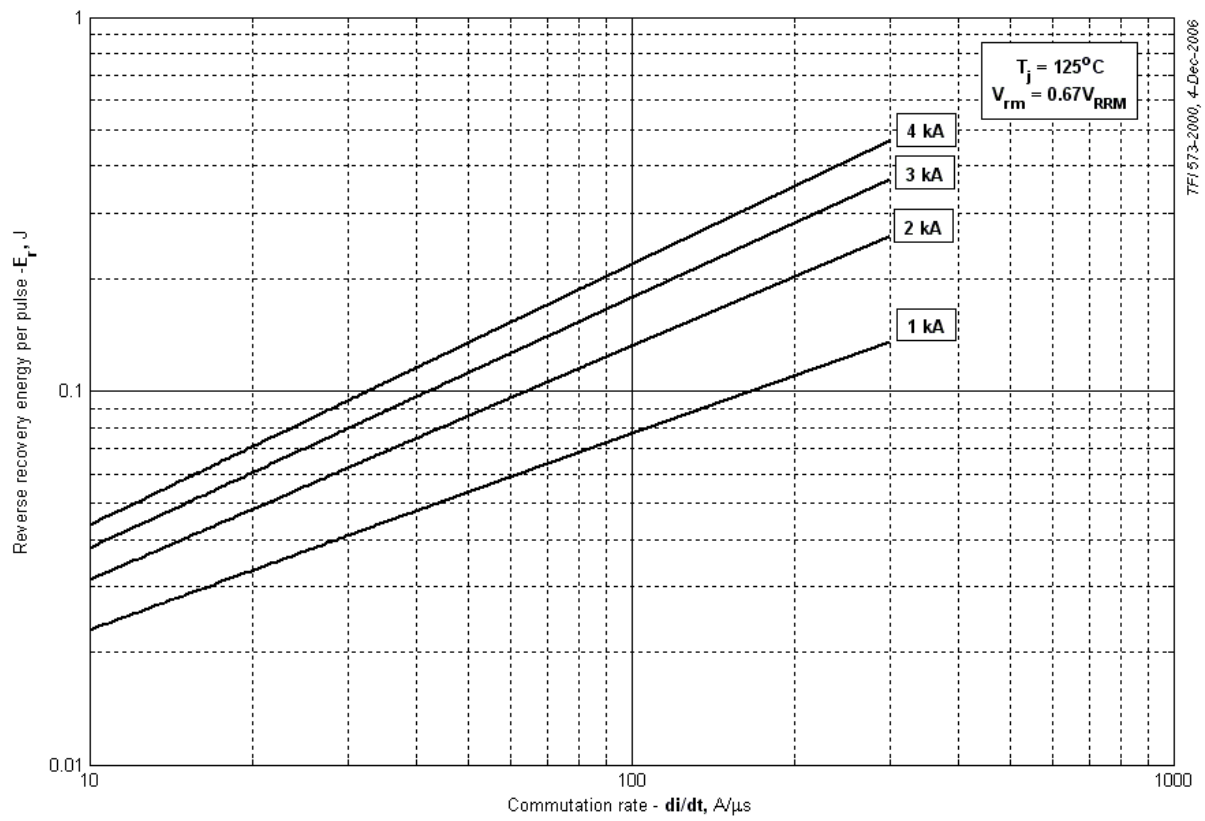


Fig 7 – Reverse recovery energy per pulse

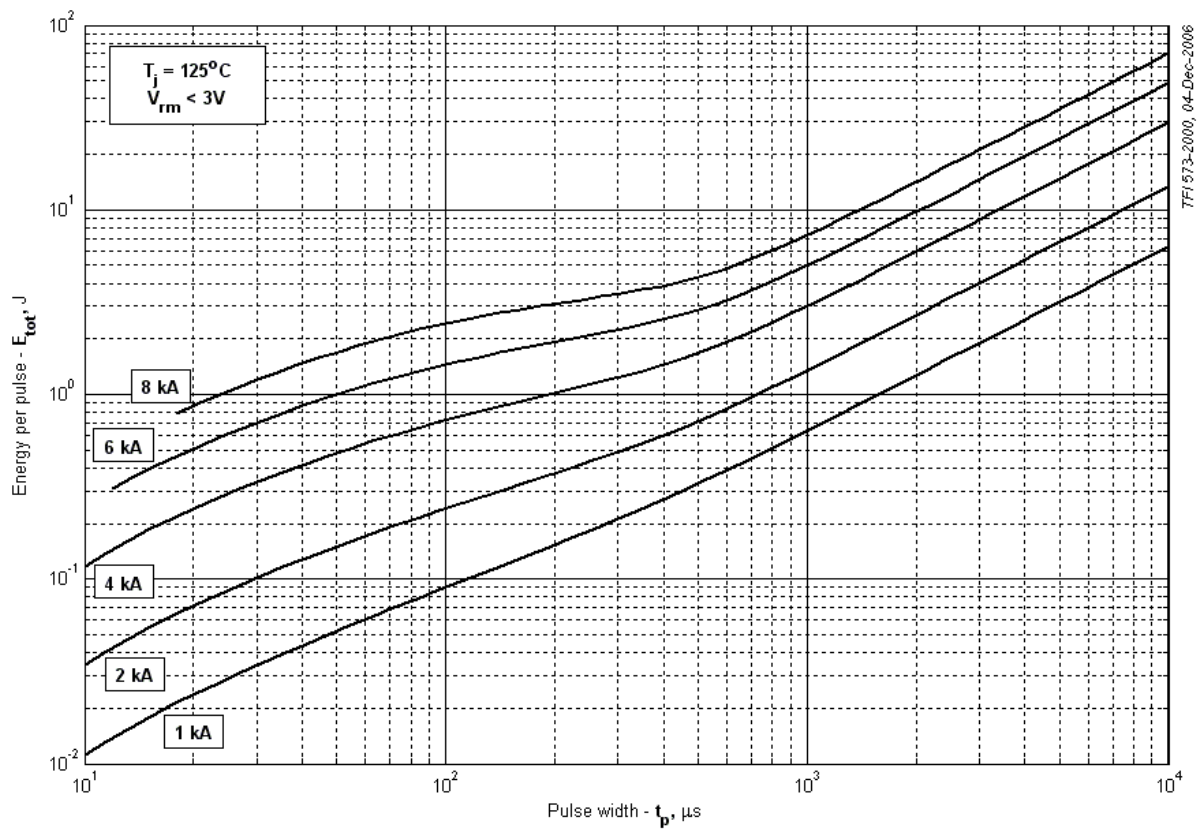


Fig 8 – Sine wave energy per pulse

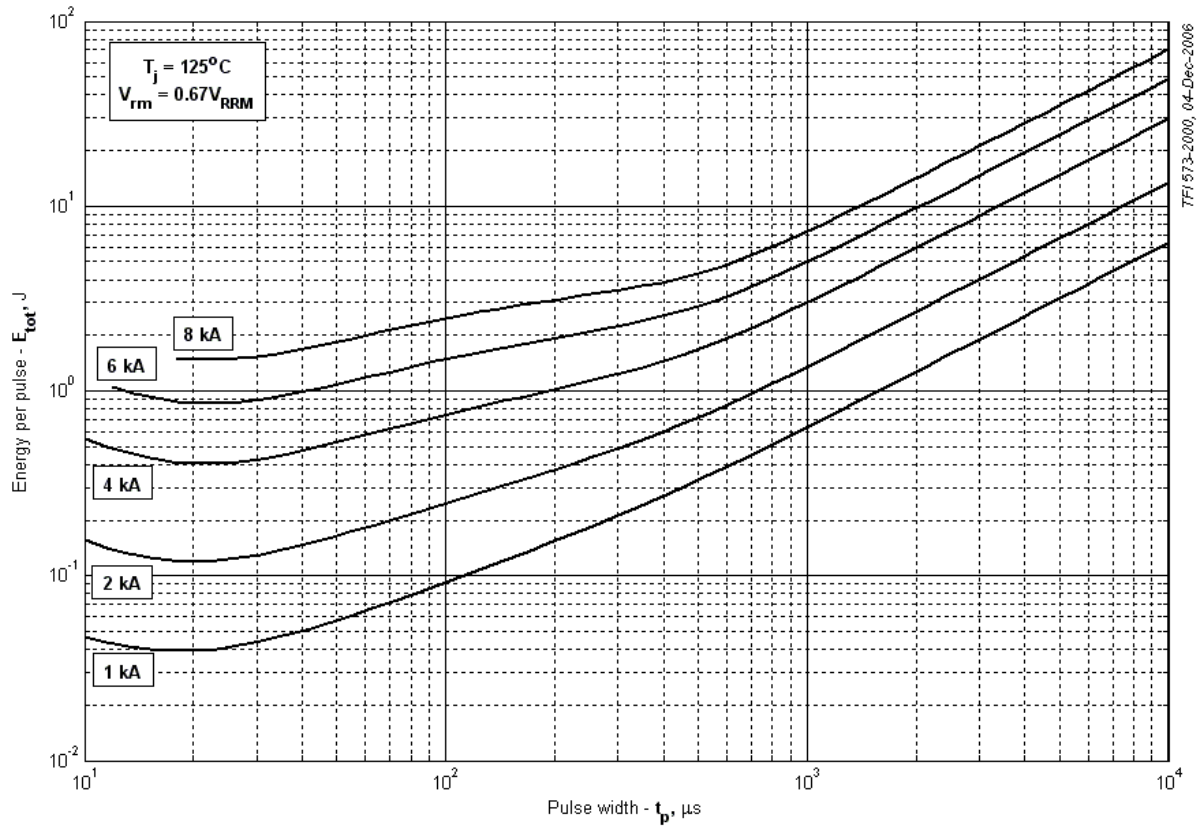


Fig 9 – Sine wave energy per pulse

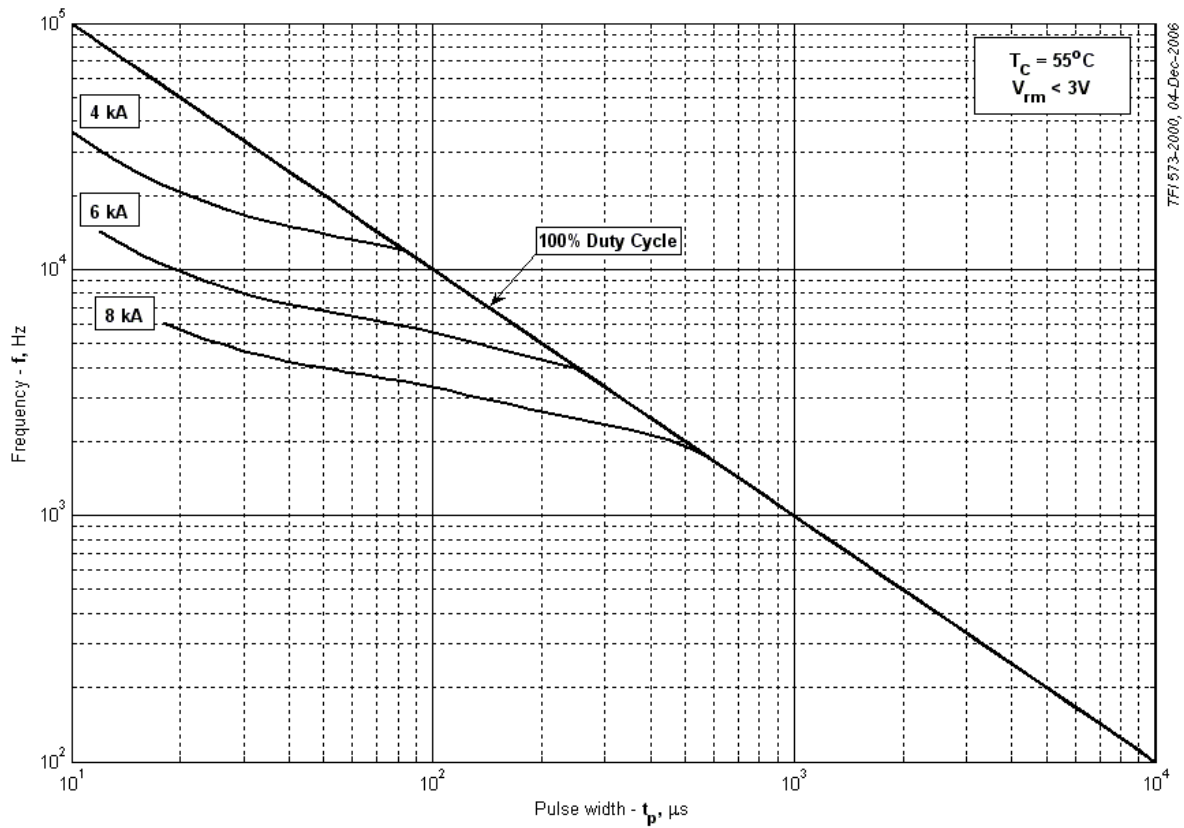


Fig 10 – Sine wave frequency ratings

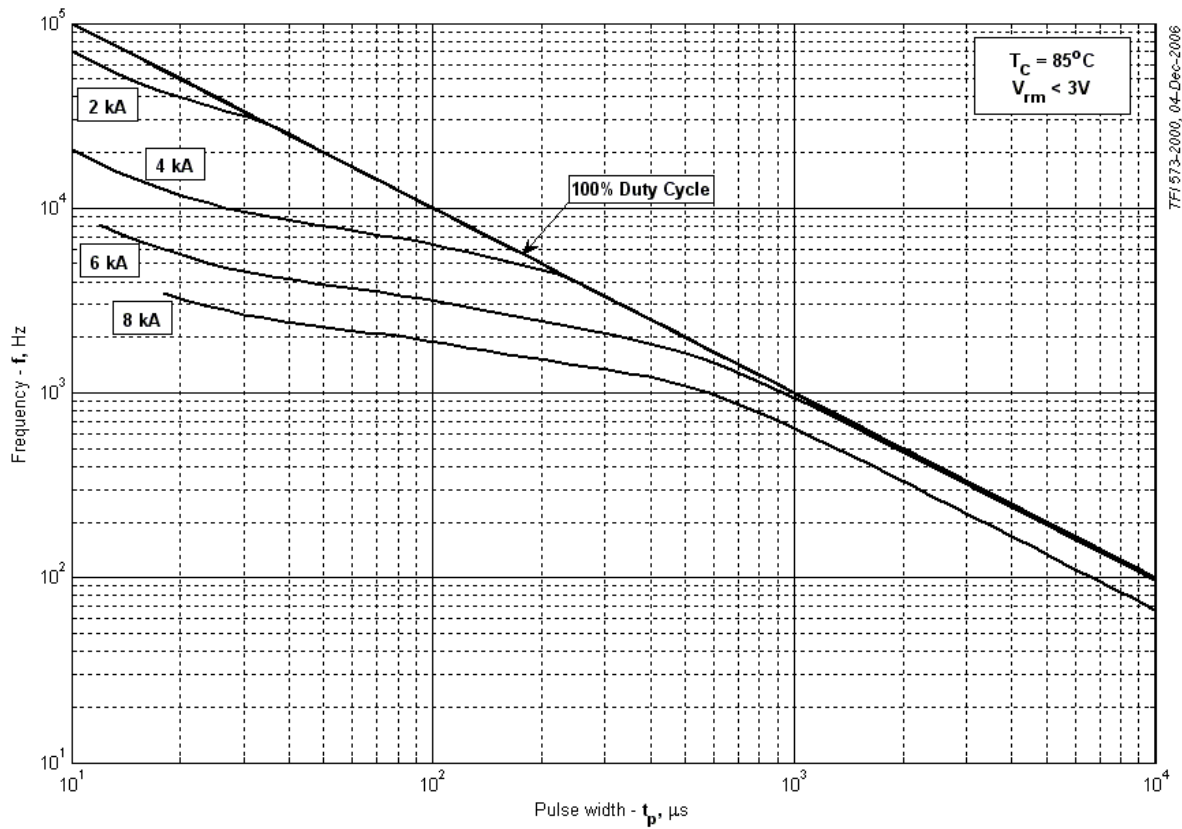


Fig 11 – Sine wave frequency ratings

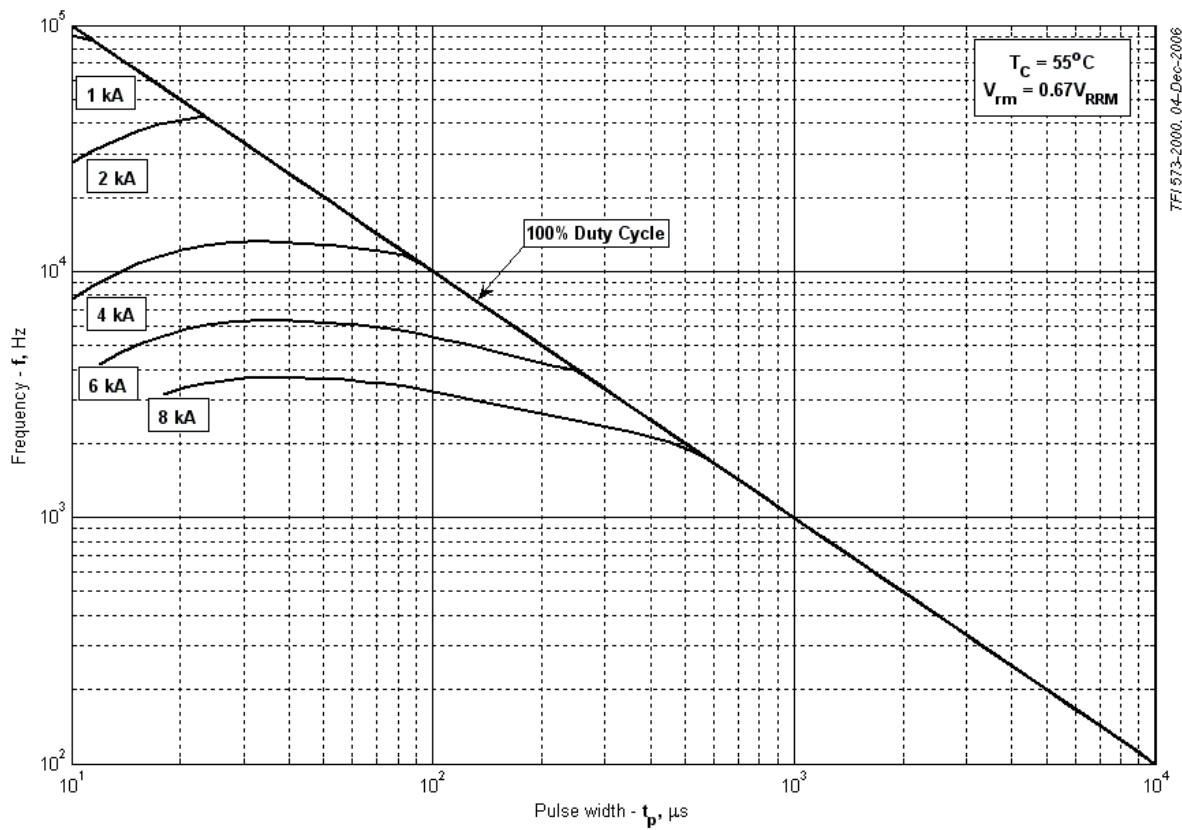
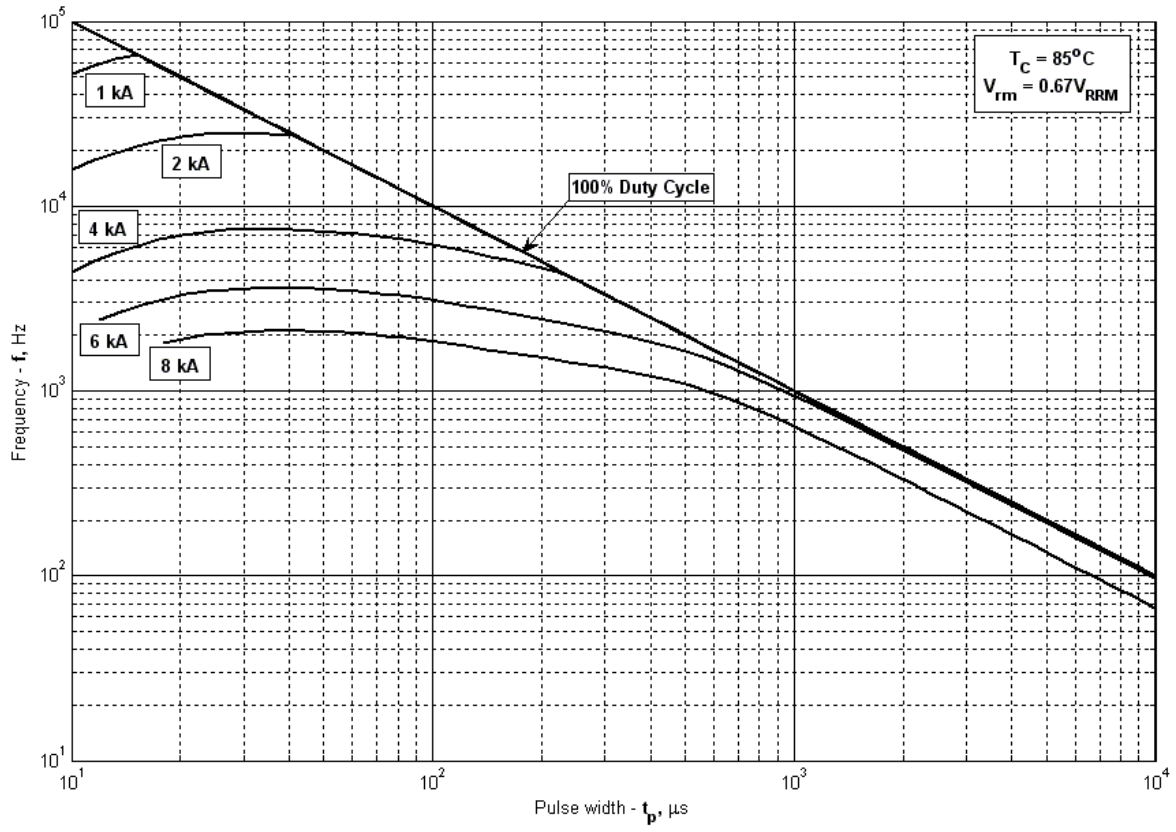
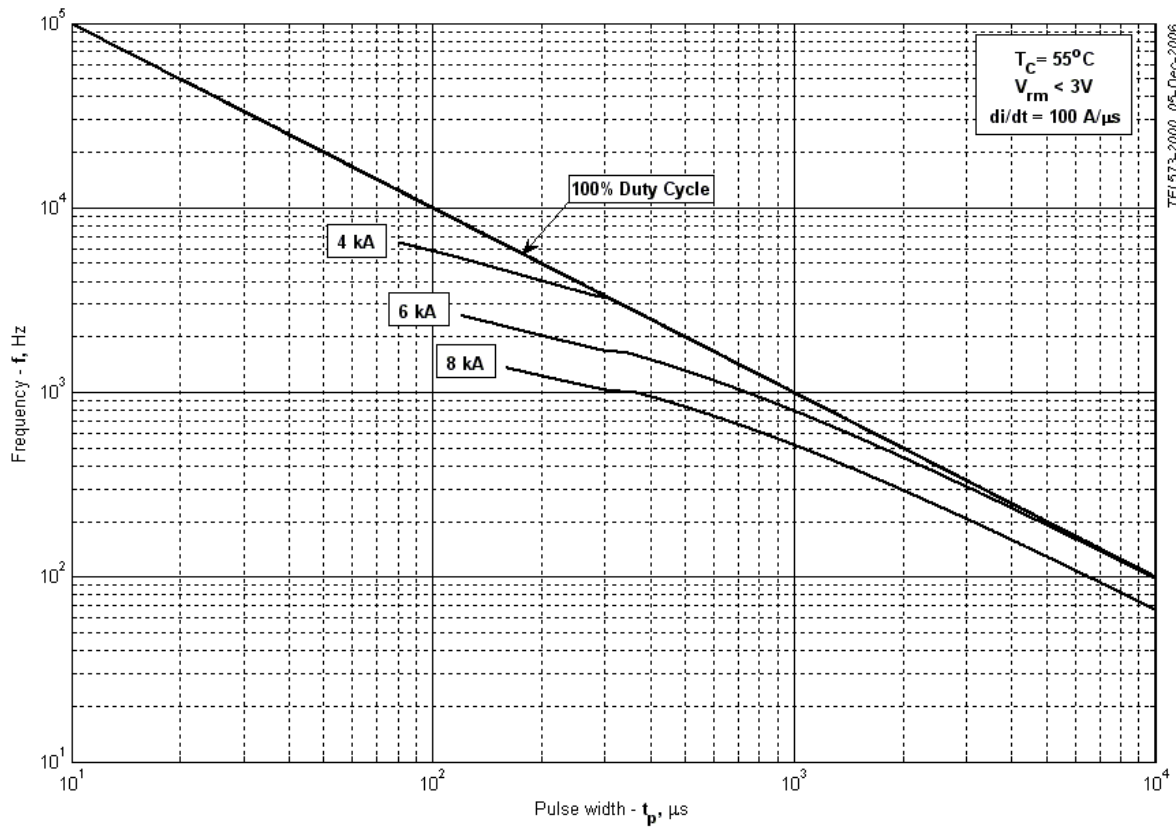


Fig 12 – Sine wave frequency ratings



TFI 573-2000, 04-Dec-2006

Fig 13 – Sine wave frequency ratings



TFI 573-2000, 05-Dec-2006

Fig 14 – Square wave frequency ratings

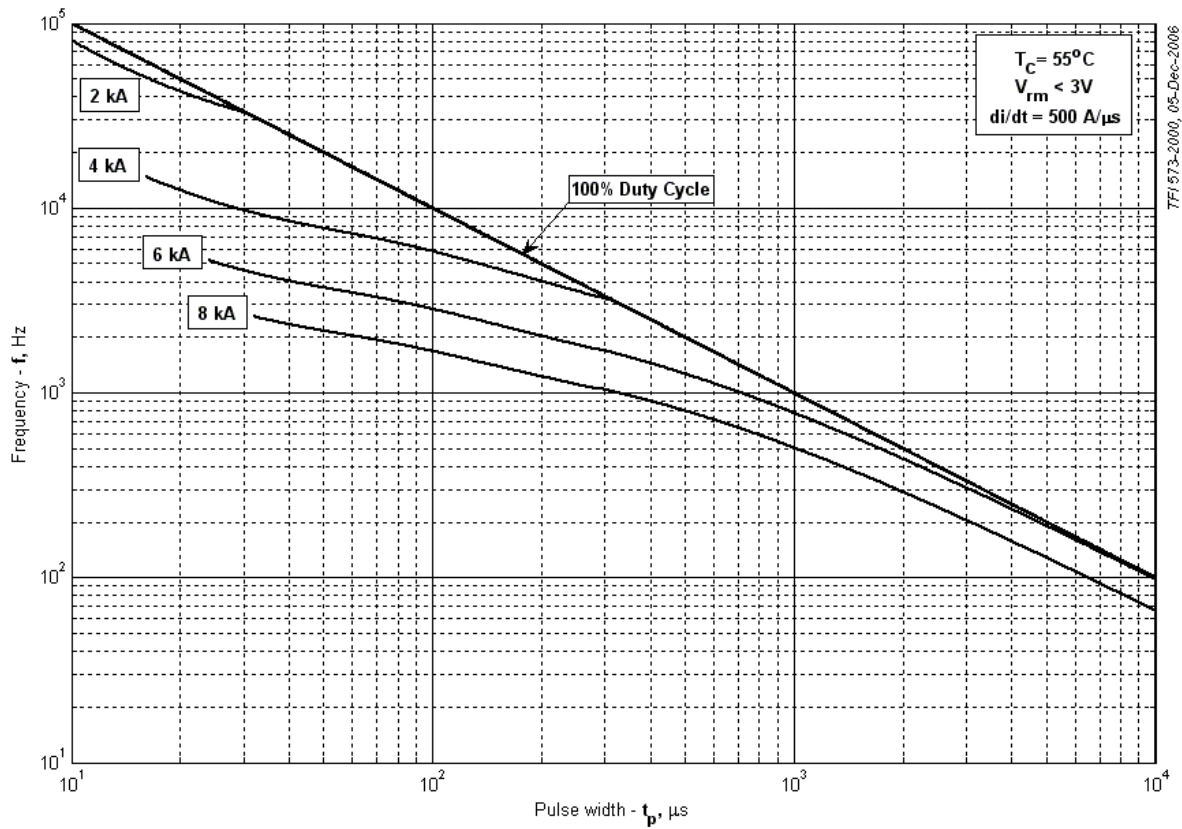


Fig 15 – Square wave frequency ratings

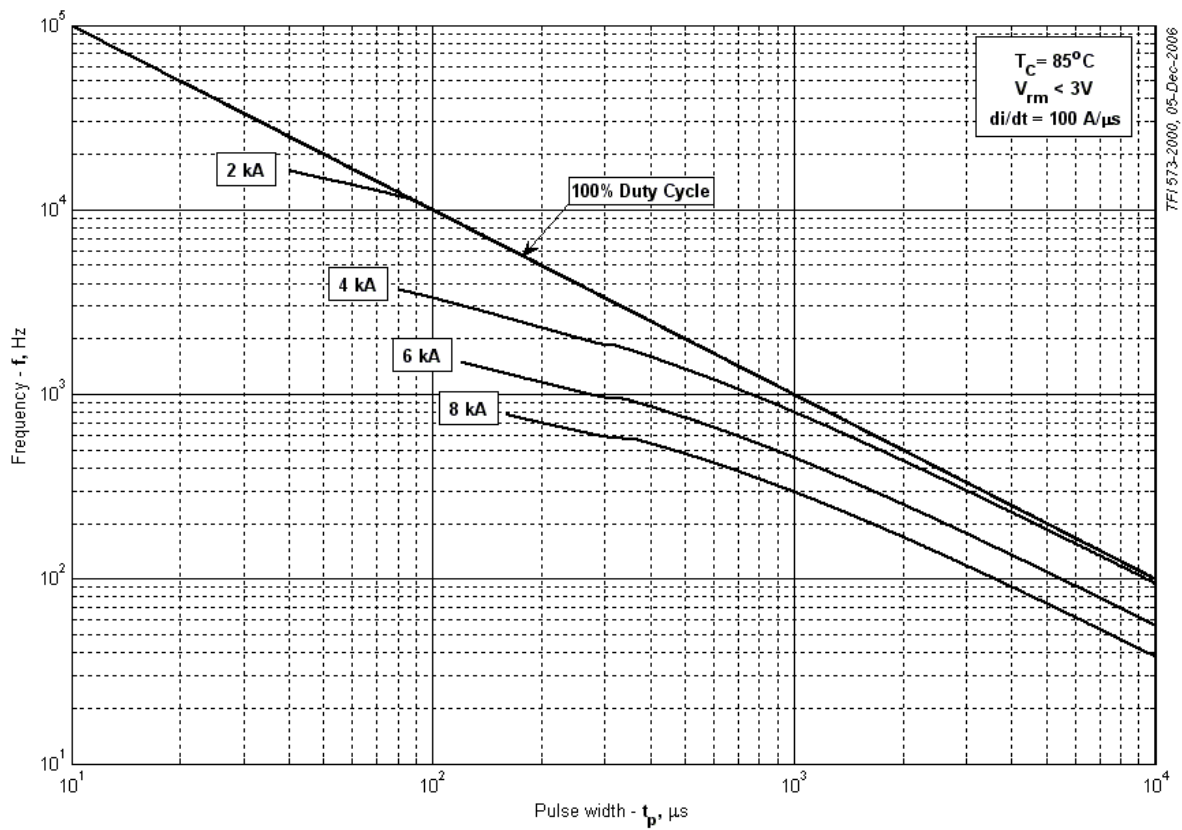


Fig 16 – Square wave frequency ratings

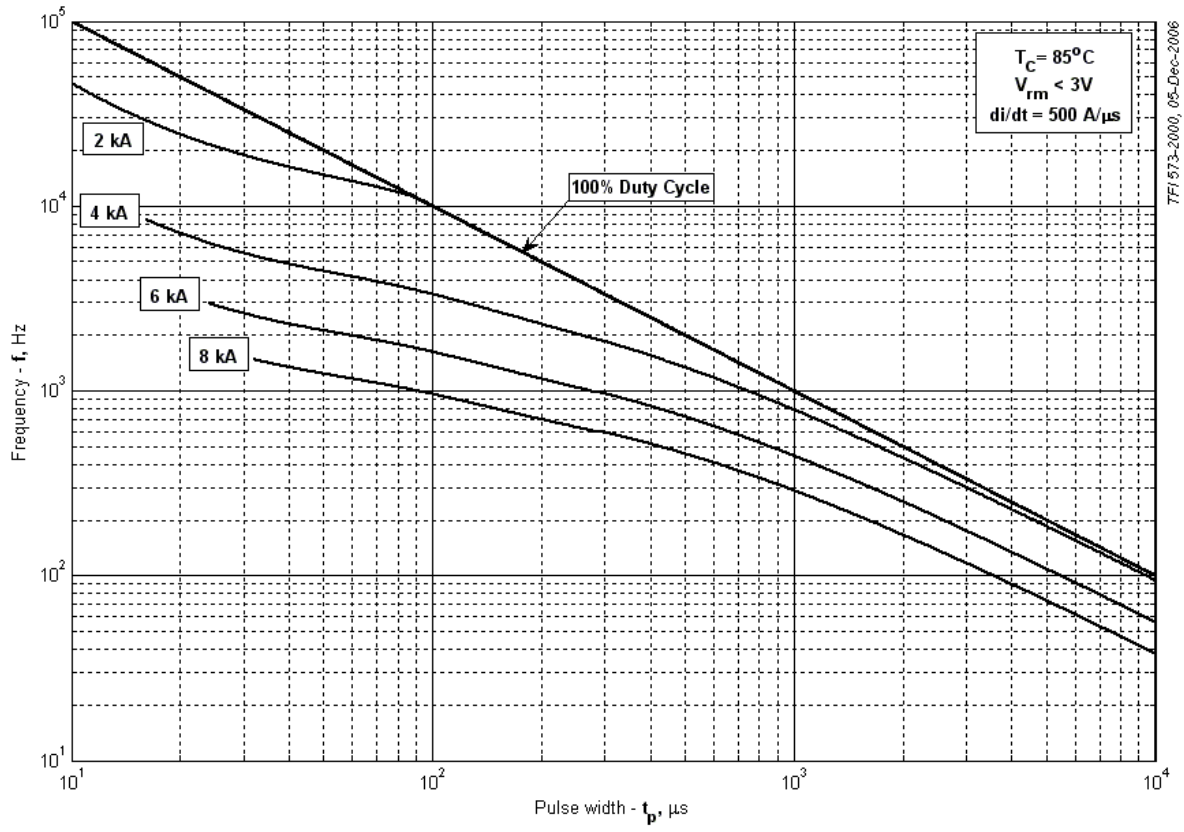


Fig 17 – Square wave frequency ratings

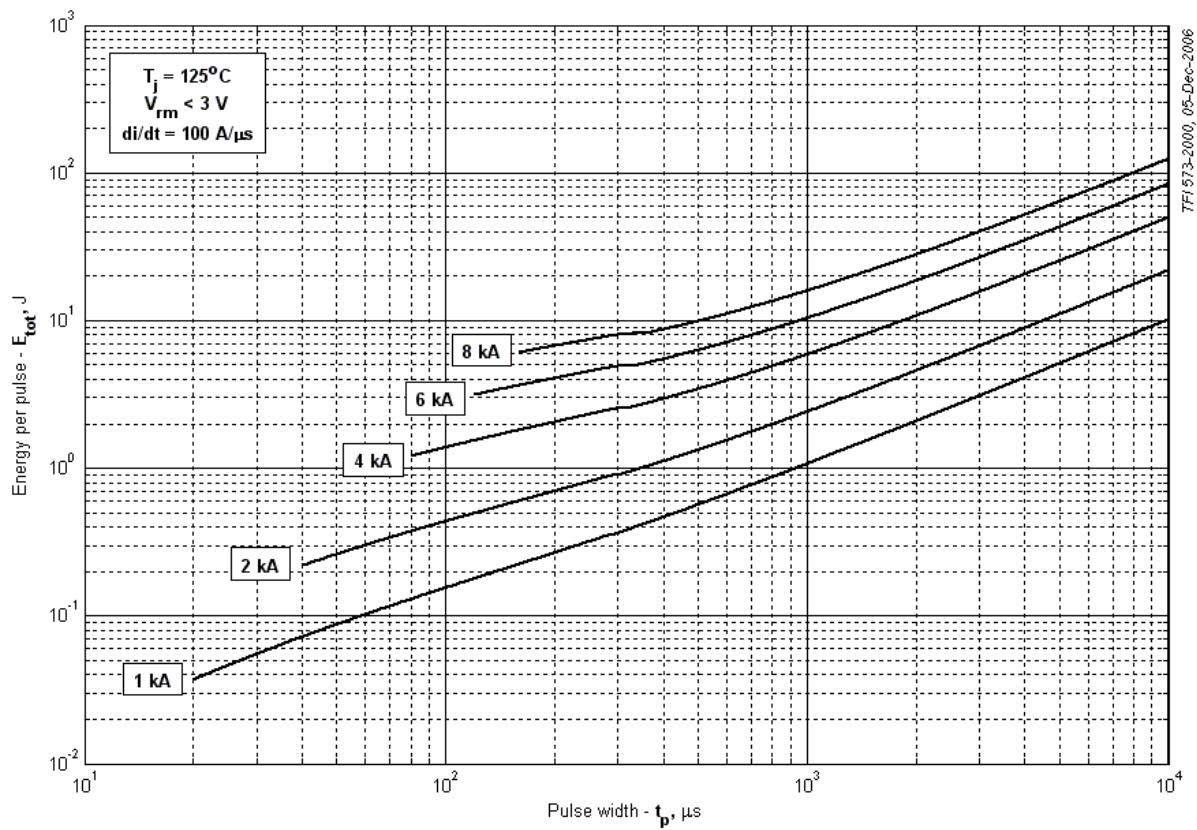


Fig 18 – Square wave energy per pulse

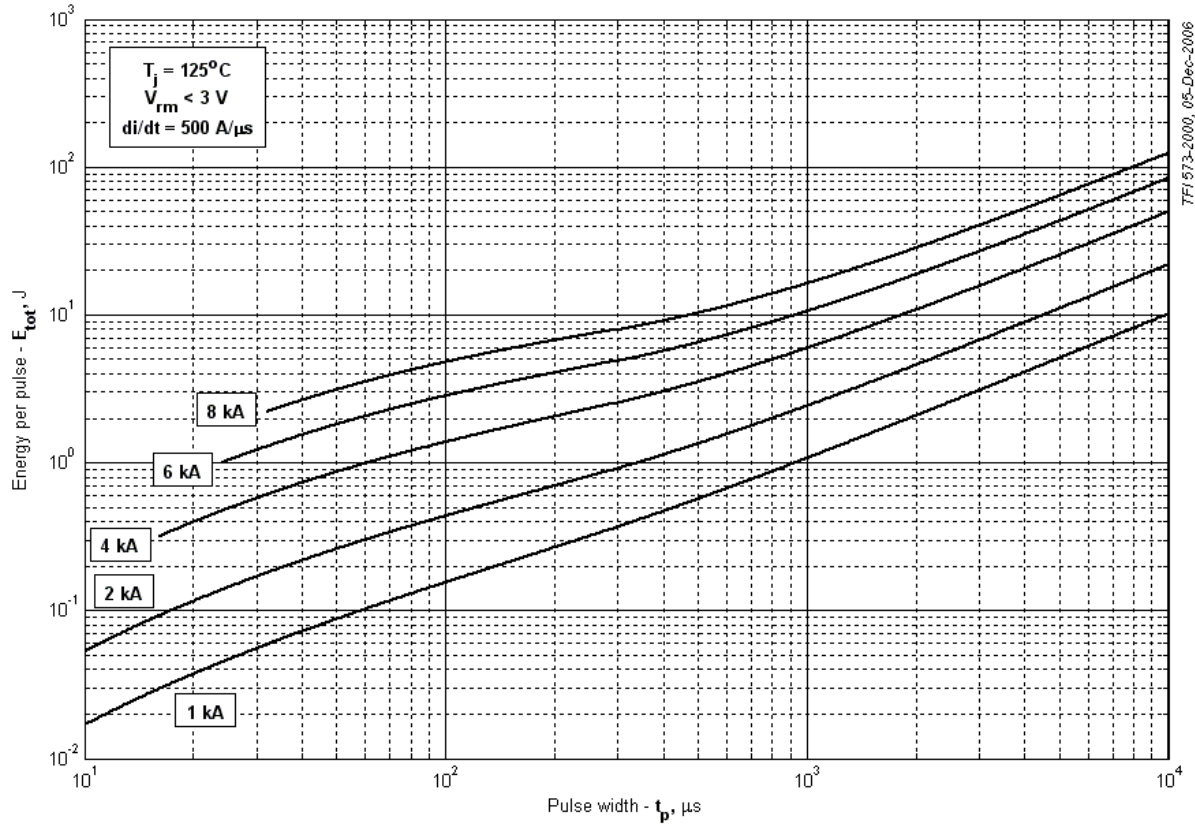


Fig 19 – Square wave energy per pulse

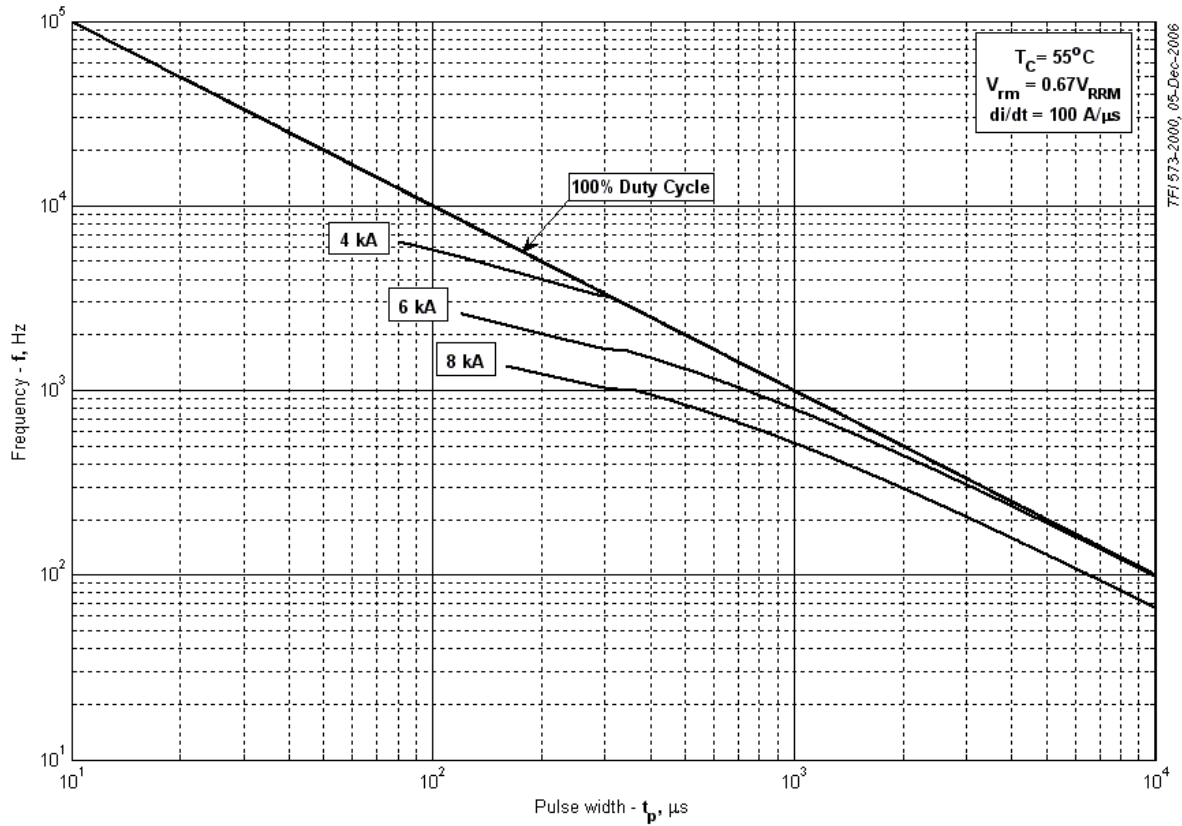


Fig 20 – Square wave frequency ratings

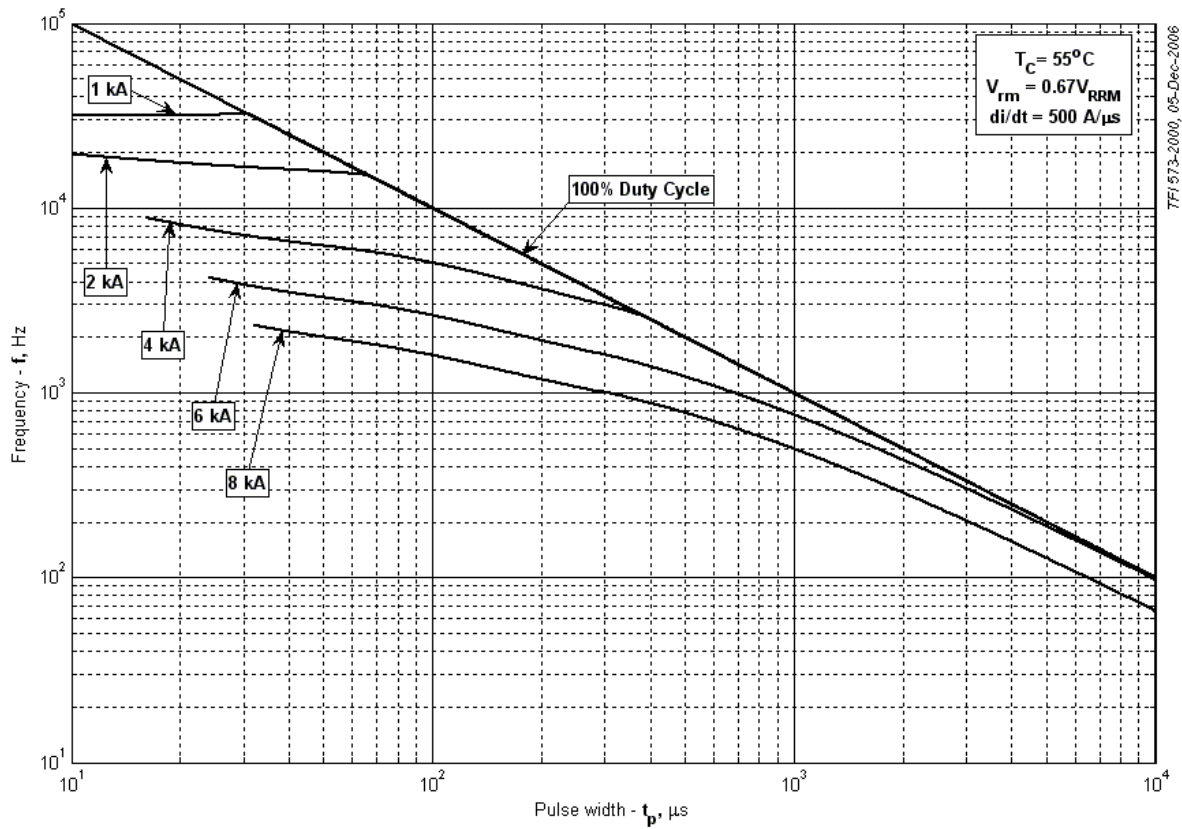


Fig 21 – Square wave frequency ratings

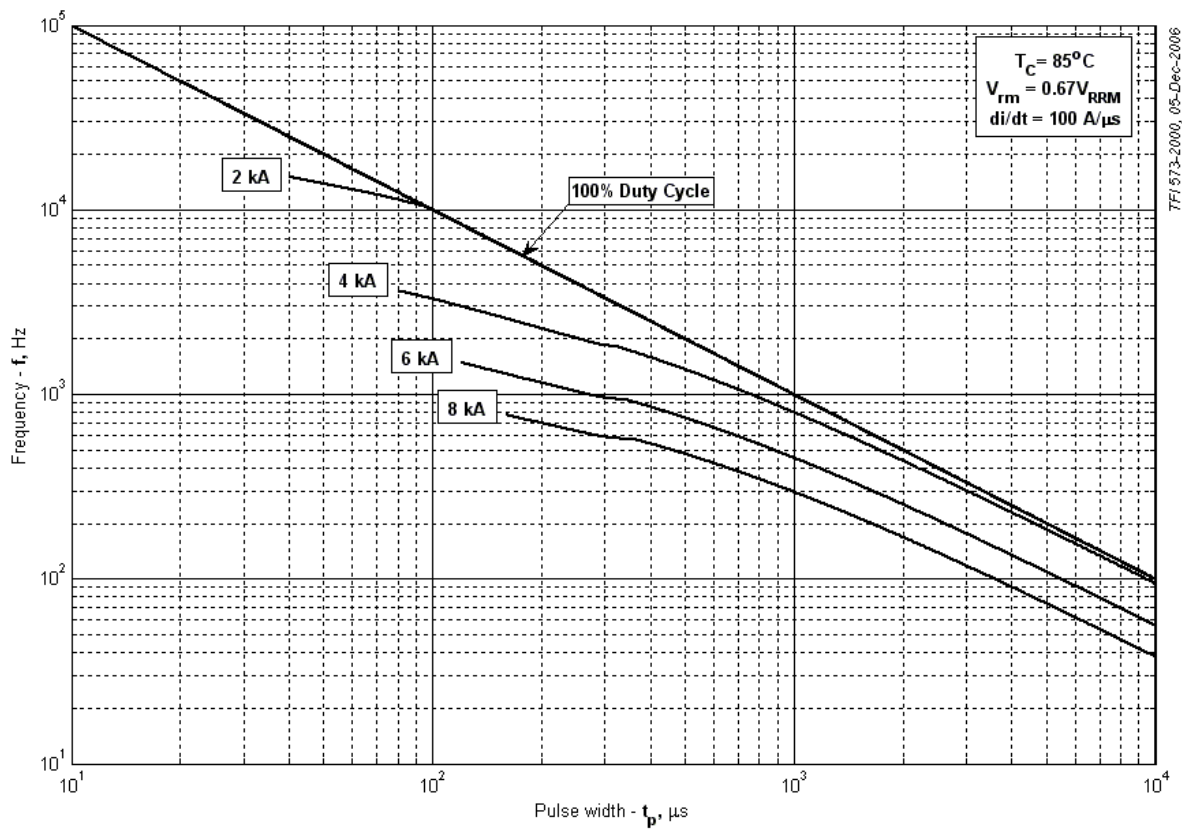


Fig 22 – Square wave frequency ratings

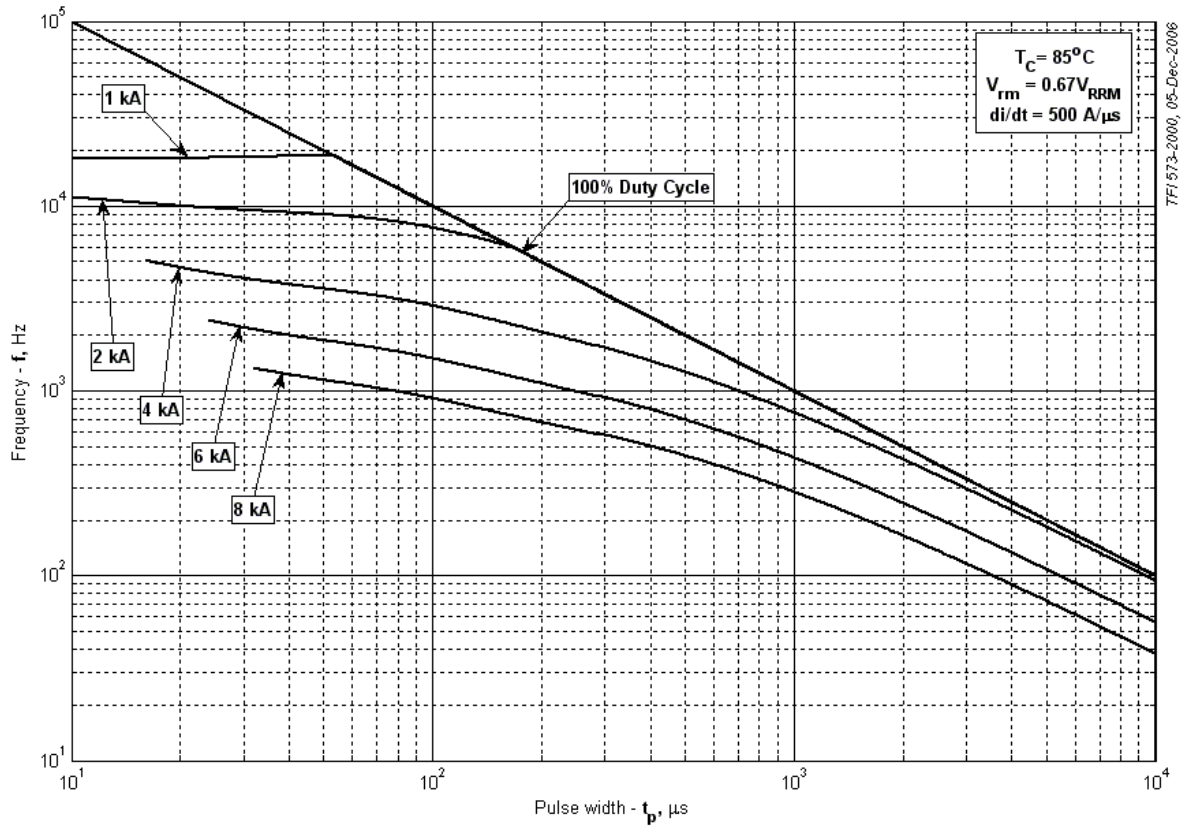


Fig 23 – Square wave frequency ratings

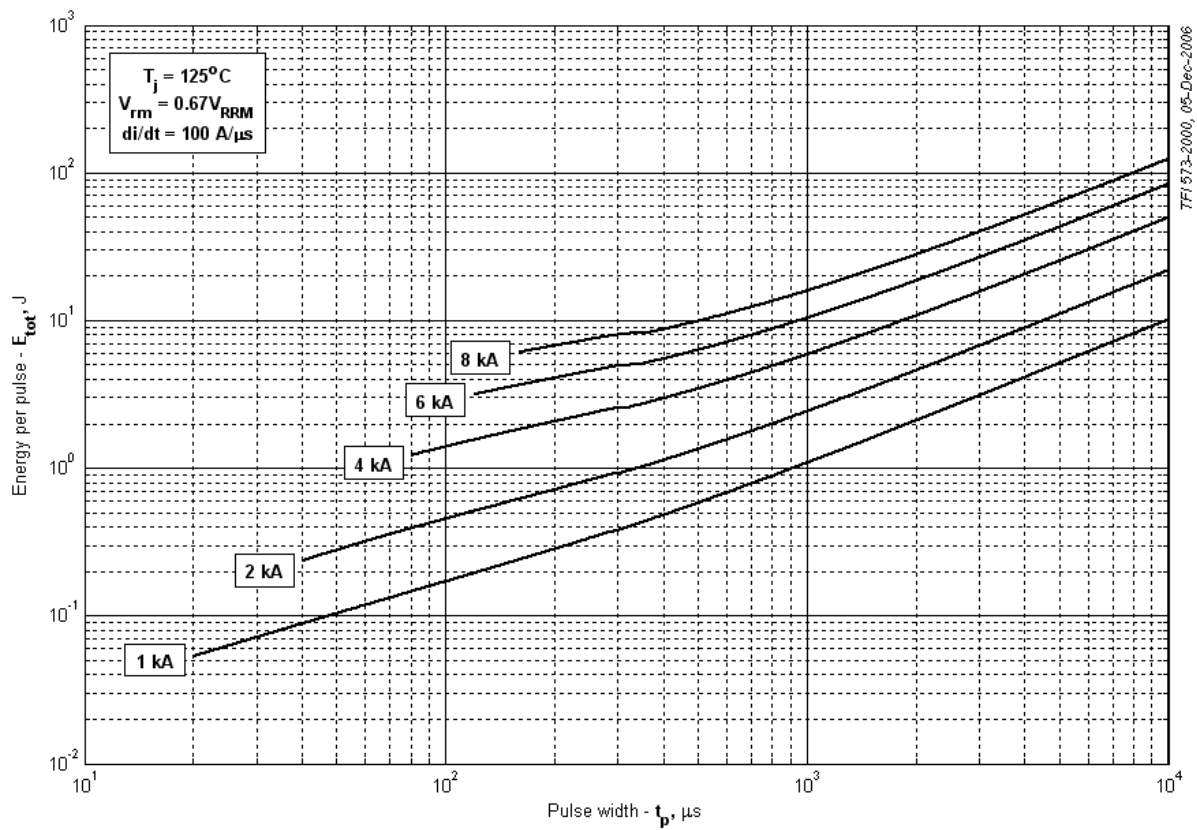


Fig 24 – Square wave energy per pulse

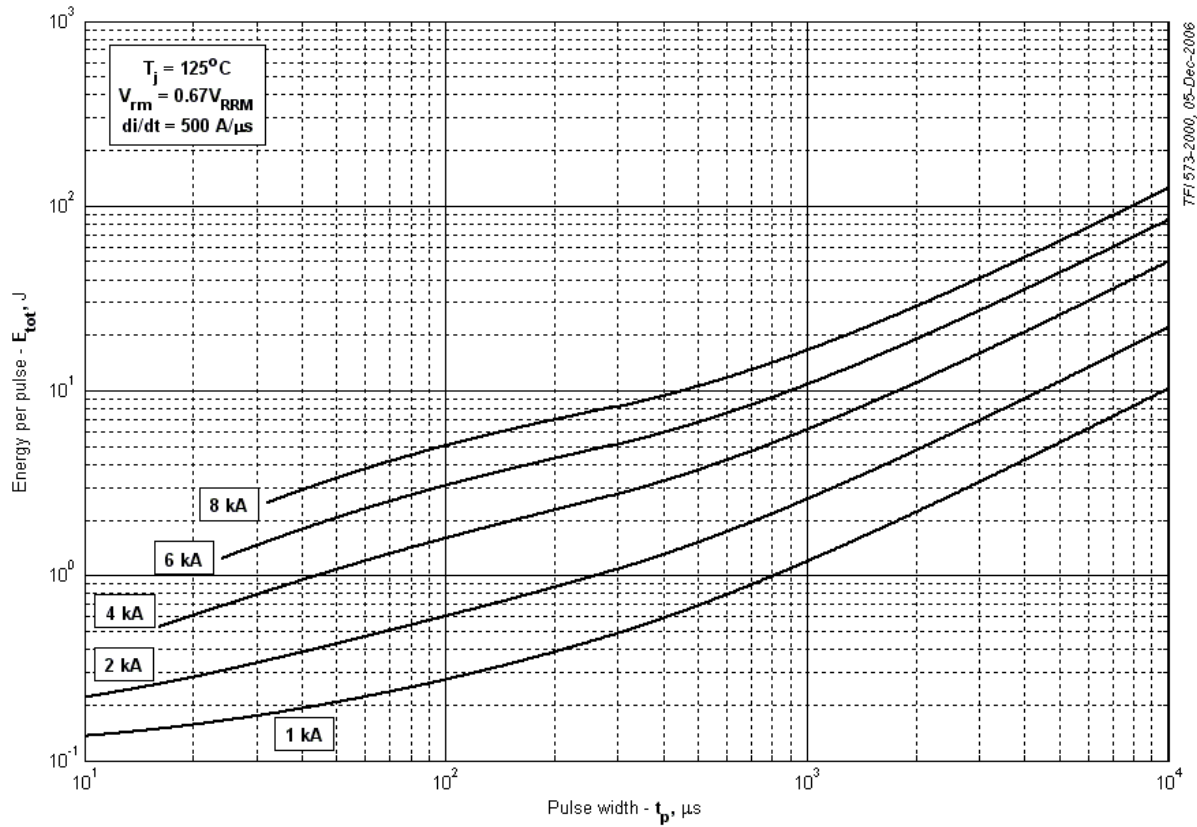


Fig 25 – Square wave energy per pulse

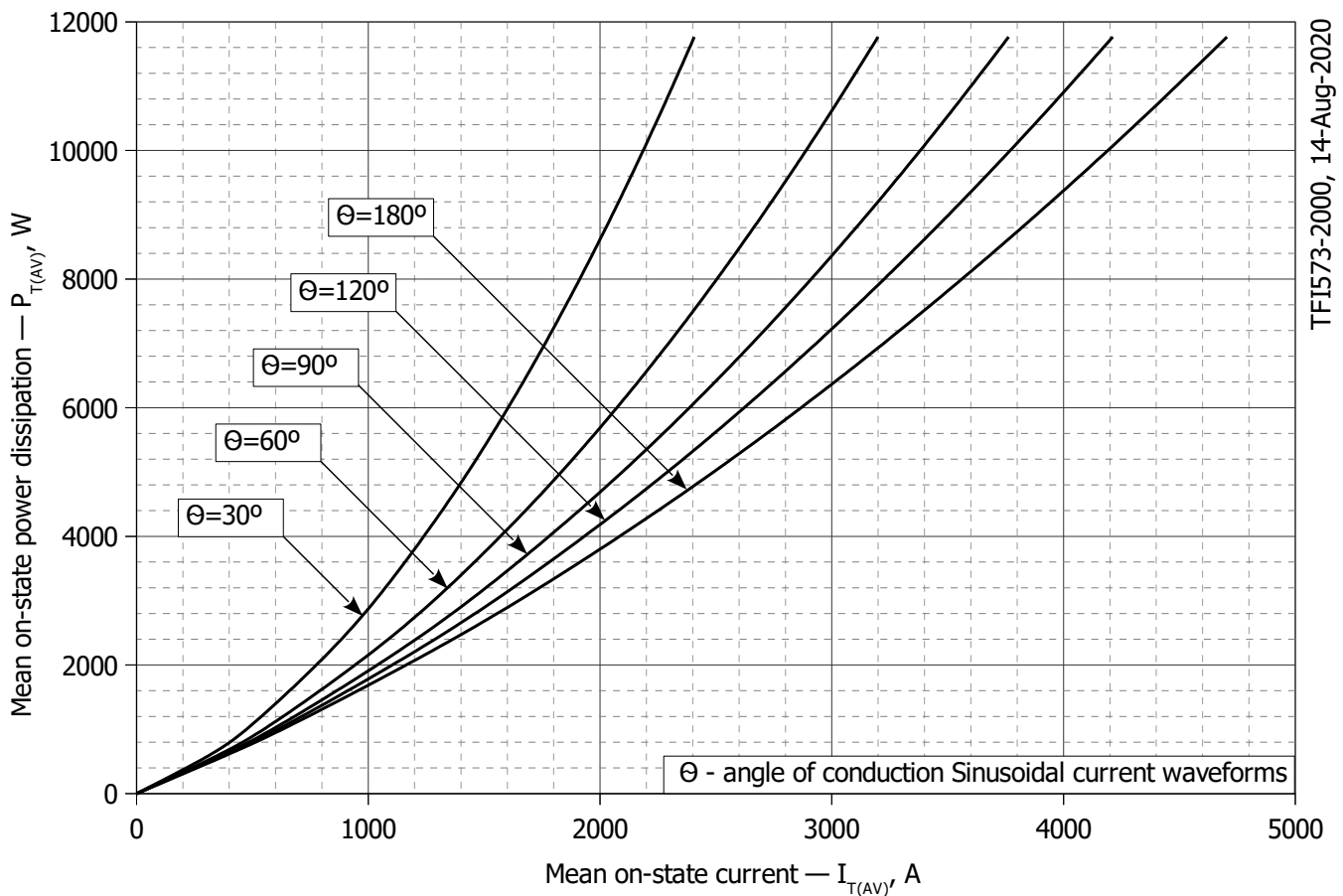
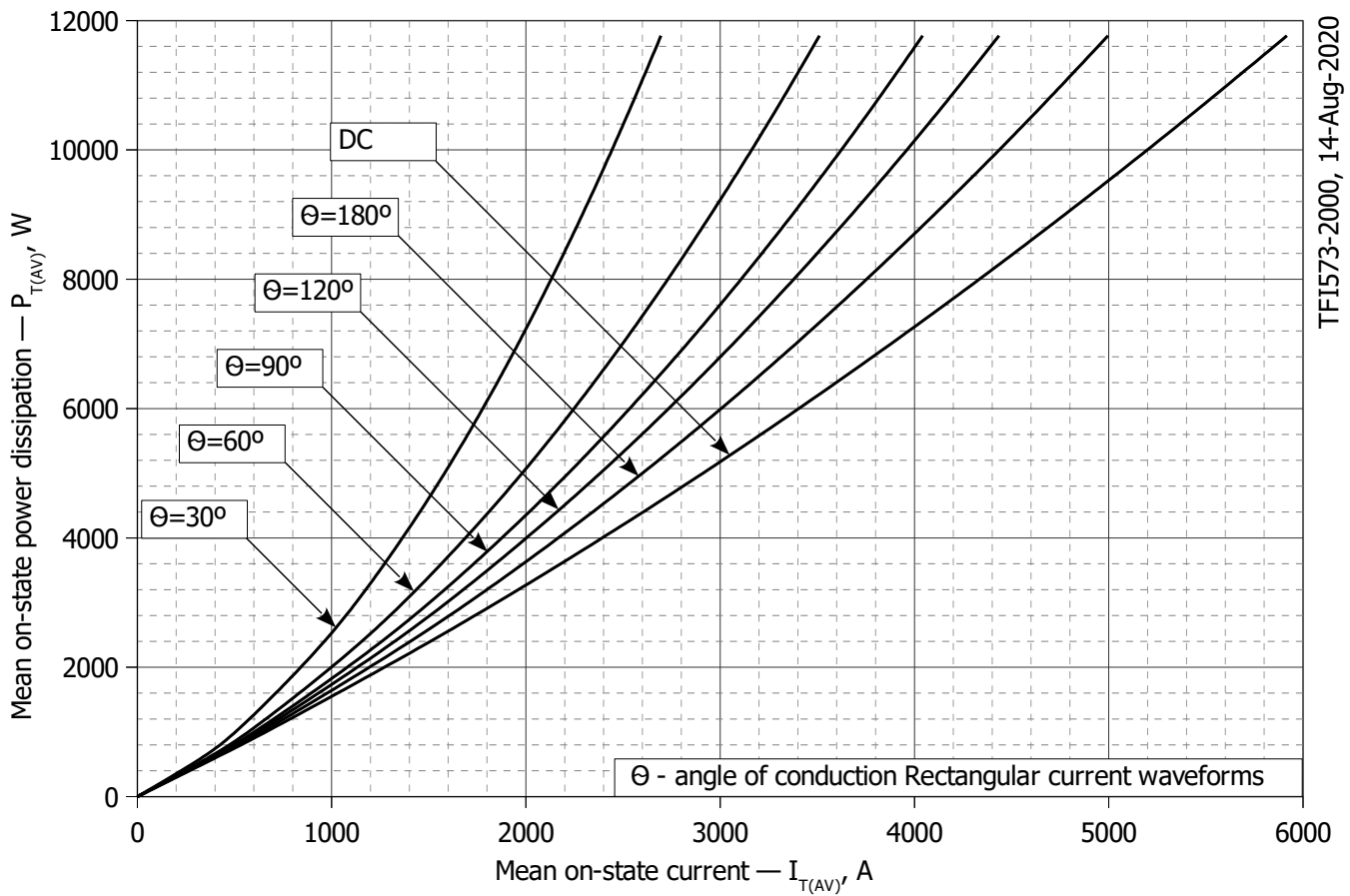
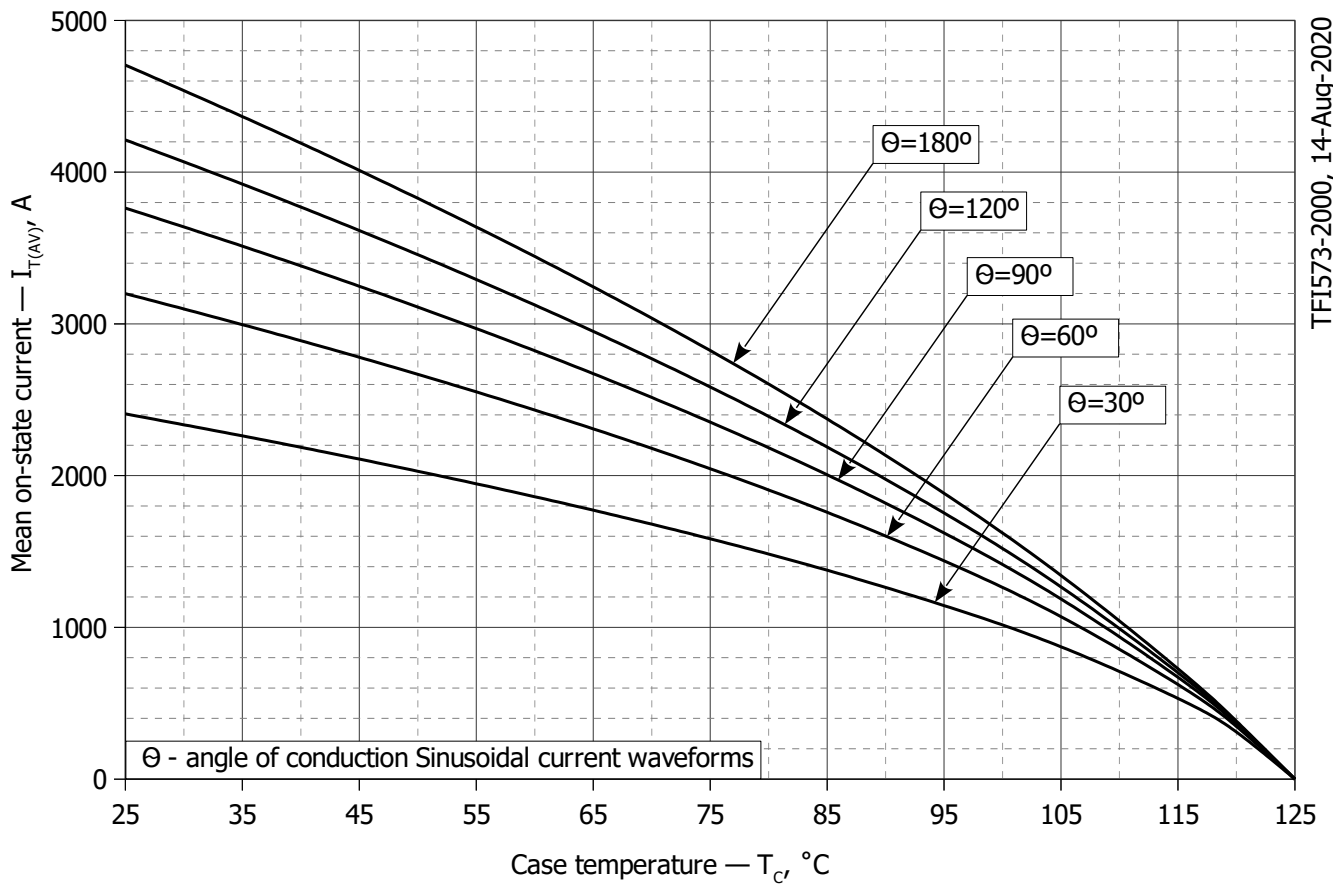


Fig 26 – On-state power loss (sinusoidal current waveforms)



TFI573-2000, 14-Aug-2020

Fig 27 - On-state power loss (rectangular current waveforms)



TFI573-2000, 14-Aug-2020

Fig 28 - Maximum case temperature (sinusoidal current waveforms)

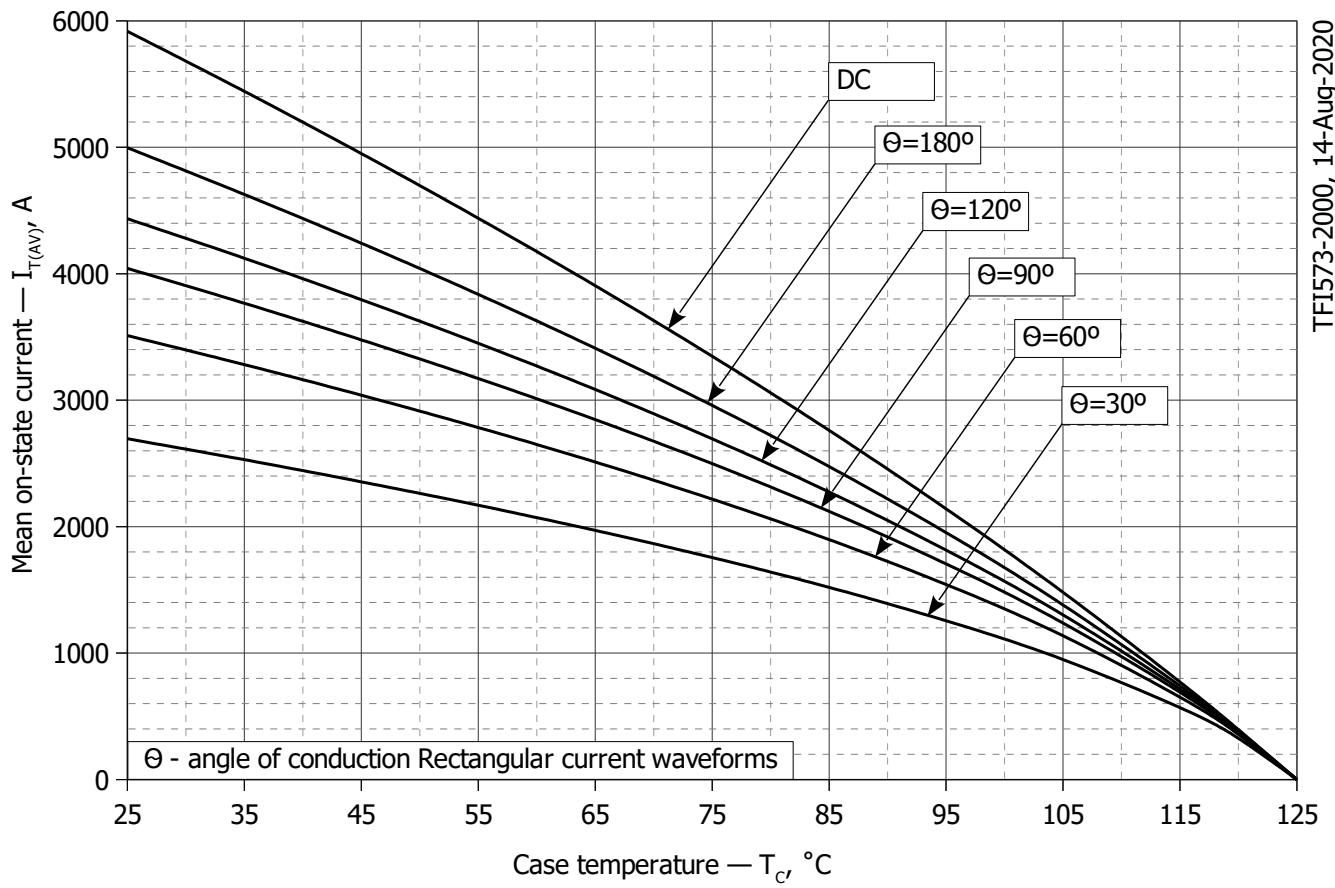


Fig 29 - Maximum case temperature (rectangular current waveforms)

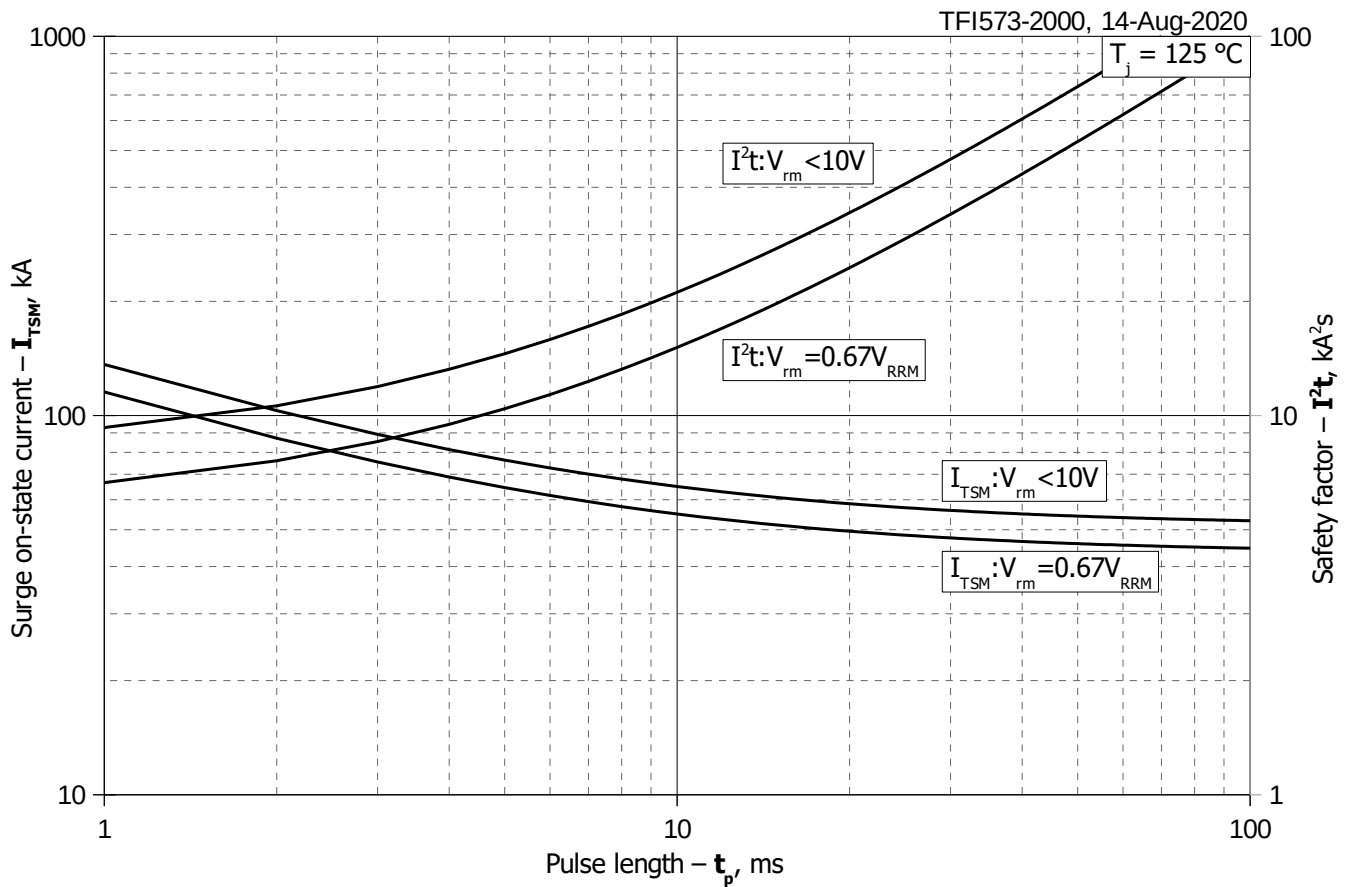
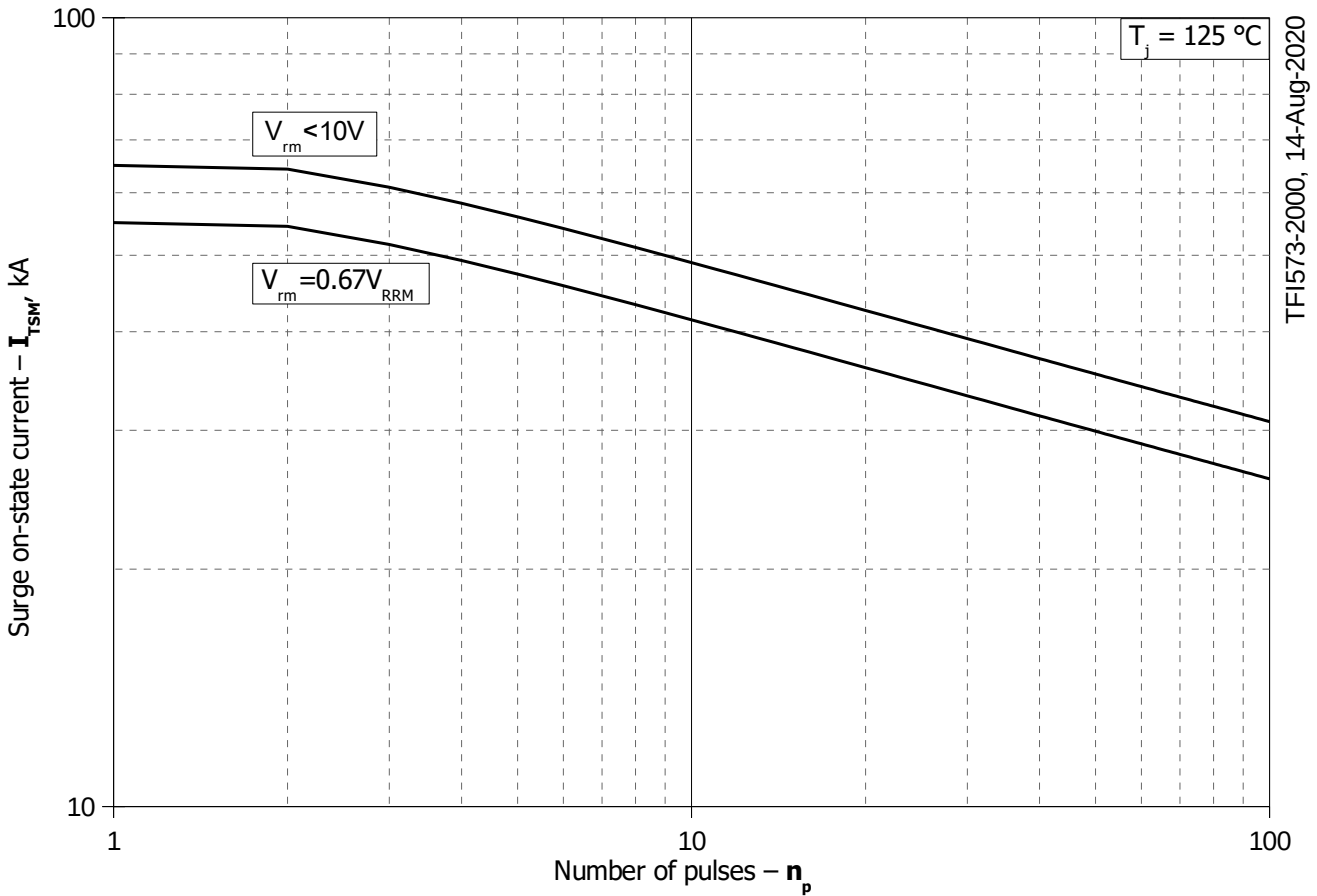


Fig 30 - Maximum surge and I^2t ratings



TFI573-2000, 14-Aug-2020

Fig 31 – Maximum surge ratings